## ProASIC ${ }^{\text {TM }} 500 \mathrm{~K}$ Family

## Features and Benefits

## High Capacity

- 100,000 to 475,000 System Gates
- 14k to 63k Bits of Two-Port SRAM
- 106 to 440 User I/Os


## Performance

- 33 MHz PCI 32-bit PCI
- Internal System Performance up to 250 MHz
- External System Performance up to 100 MHz


## Low Power

- Low Impedance Flash Switches
- Segmented Hierarchical Routing Structure
- Small, Efficient Logic Cells


## High Performance Routing Hierarchy

- Ultra Fast Local Network
- Efficient Long Line Network
- High Speed Very Long Line Network
- High Performance Global Network


## Nonvolatile and Reprogrammable Flash Technology

- Live at Power Up
- No Configuration Device Required
- Retains Programmed Design During Power-Down/ Power-Up Cycles


## I/O

- Mixed 2.5V/3.3V Support with Individually-Selectable Voltage and Slew Rate
- 3.3V, PCI Compliance (PCI Revision 2.2)


## Secure Programming

The Industry's Most Effective Security Key Prevents Read Back of Programming Bit Stream

## Standard FPGA and ASIC Design FIow

- Flexibility with Choice of Industry-Standard Front-End Tools
- Efficient Design Through Front-End Timing and Gate Optimization


## ISP Support

- In-System Programming (ISP) with Silicon Sculptor and Flash Pro


## SRAMs and FIFOs

- Up to 150 MHz Synchronous and Asynchronous Operation
- Netlist Generator Ensures Optimal Usage of Embedded Memory Blocks


## Boundary Scan Test

IEEE Std. 1149.1 (JTAG) Compliant

ProASIC Product Profile

| Device | A500K050 | A500K130 | A500K180 | A500K270 |
| :--- | :---: | :---: | :---: | :---: |
| Maximum System Gates | 100,000 | 290,000 | 370,000 | 475,000 |
| Typical Gates | 43,000 | 105,000 | 150,000 | 215,000 |
| Maximum Flip-Flops | 5,376 | 12,800 | 18,432 | 26,880 |
| Embedded RAM Bits | 14 k | 45 k | 54 k | 63 k |
| Embedded RAM Blocks (256 X 9) | 6 | 20 | 24 | 28 |
| Logic Tiles | 5,376 | 12,800 | 18,432 | 26,880 |
| Global Routing Resources | 4 | 4 | 4 | 4 |
| Maximum User I/Os | 204 | 306 | 362 | 440 |
| JTAG | Yes | Yes | Yes | Yes |
| PCI | Yes | Yes | Yes | Yes |
| Package (by Pin Count) |  |  |  |  |
| PQFP | 208 | 208 | 208 | 208 |
| PBGA | 272 | 272,456 | 456 | 456 |
| FBGA | 144 | 144,256 | 256 | 256,676 |

## General Description

The ProASIC 500K family's nonvolatile Flash technology combines the advantages of ASICs with the benefits of programmable devices. ProASIC 500K devices shorten time-to-production by enabling designers to create high-density systems using existing ASIC or FPGA design flows and tools. ASIC migration is not necessary for any volume because the family offers cost effective reprogrammable solutions, ideal for applications in the networking, telecom, computer, and consumer markets.

The ProASIC 500 K family consists of four devices ranging from 100 k to 475 k system gates and with up to 63 k bits of
embedded two-port memory. These memory blocks include hardwired FIFO circuitry as well as circuits to generate or check parity. This minimizes external logic gate count and complexity while maximizing flexibility and utility.

## Process Technology

The ProASIC 500 K family achieves its nonvolatile and reprogrammability through an advanced $0.25 \mu$, four-level metal LVCMOS process enhanced with Flash technology. The use of standard CMOS design techniques to implement logic and control functions results in highly predictable performance and gate array compatibility.

## Ordering Information



## Product Plan

|  | Application |  |
| :---: | :---: | :---: |
|  | C | I |
| A500K050 Device |  |  |
| 144-Pin Fine Ball Grid Array (FBGA) | $\checkmark$ | $\checkmark$ |
| 208-Pin Plastic Quad Flat Pack (PQFP) | $\checkmark$ | $\checkmark$ |
| 272-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| A500K130 Device |  |  |
| 144-Pin Fine Ball Grid Array (FBGA) | $\checkmark$ | $\checkmark$ |
| 208-Pin Plastic Quad Flat Pack (PQFP) | $\checkmark$ | $\checkmark$ |
| 272-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| 256-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| 456-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| A500K180 Device |  |  |
| 208-Pin Plastic Quad Flat Pack (PQFP) | $\checkmark$ | $\checkmark$ |
| 256-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| 456-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| A500K270 Device |  |  |
| 208-Pin Plastic Quad Flat Pack (PQFP) | $\checkmark$ | $\checkmark$ |
| 256-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| 456-Pin Plastic Ball Grid Array (PBGA) | $\checkmark$ | $\checkmark$ |
| 676-Pin Fine Ball Grid Array (FBGA) | $\checkmark$ | $\checkmark$ |

Contact your Actel sales representative for package availability.
Applications: $\quad C=$ Commercial Availability: $\boldsymbol{\checkmark}=$ Available - Contact your Actel Sale's representative for the latest $I=$ Industrial availability information.

## Plastic Device Resources

|  | User I/Os |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Device | PQFP <br> 208-Pin | PBGA <br> 272-Pin | PBGA <br> 456-Pin | FBGA <br> 144-Pin | FBGA <br> 256-Pin | FBGA <br> 676-Pin |
| A500K050 | 164 | 204 | - | 106 | - | - |
| A500K130 | 164 | 204 | 306 | 106 | 192 | - |
| A500K180 | 164 | - | 362 | - | 192 | - |
| A500K270 | 164 | - | 362 | - | 192 | 440 |

## Package Definitions

$P Q F P=$ Plastic Quad Flat Pack, $P B G A=$ Plastic Ball Grid Array,$F B G A=$ Fine Ball Grid Array

## ProASIC 500K Architecture

The ProASIC 500K family's proprietary architecture provides granularity comparable to gate arrays. Unlike SRAM-based FPGAs that utilize look-up tables or architectural mapping during design, ProASIC device designs are directly synthesized to gates. That streamlines the design flow, increases design productivity, and eliminates dependencies on vendor-specific design tools.
The ProASIC 500 K device core consists of a Sea-of-Tiles ${ }^{\text {TM }}$ (Figure 1), each of which can be configured as a 3 -input logic function (e.g., NAND gate, D-Flip-Flop, etc.) by programming the appropriate Flash switch interconnections (See Figure 2 on page 5 and Figure 3 on page 5). Gates and larger functions are connected with four levels of routing hierarchy. Flash memory bits are distributed throughout the device to provide nonvolatile, reconfigurable interconnect programming. Flash switches are programmed to connect signal lines to the appropriate logic cell inputs and outputs. Dedicated high-performance lines are connected as needed for fast, low-skew global signal distribution throughout the core. Maximum core utilization is possible for virtually any design.

The ProASIC 500K devices also contain embedded two-port SRAM blocks with built-in FIFO/RAM control logic.

Programming options include synchronous or asynchronous operation, two-port RAM configurations, user defined depth and width, and parity generation or checking. Table 3 on page 12 lists the 24 basic memory configurations.

## Flash Switch

In the ProASIC Flash switch, two transistors share the floating gate which stores the programming information. One is the Flash transistor which stores programming information and in which erasing is performed. The second transistor connects/separates routing elements or configuration signal lines (Figure 2 on page 5).

## Logic Tile

The logic tile cell, Figure 3 on page 5, has three inputs (any or all of which can be inverted) and one output (which can connect to both ultra fast local and efficient long line routing resources). Any three-input one-output logic function, except a three input X0R, can be configured as one tile. Two multiplexers with feedback paths through the NAND gates allow the tile to be configured as a latch with clear or set, or as a flip-flop with clear or set. Thus, the tiles can flexibly map logic and sequential gates of a design.


Figure 1 - The ProASIC Device Architecture


Figure 2 • Flash Switch


Figure 3 - Core Logic Tile

## Routing Resources

The routing structure of the ProASIC 500 K devices is designed to provide high performance through a flexible four-level hierarchy of routing resources: ultra fast local resources, efficient long line resources, high speed very long line resources, and high performance global networks.

The ultra fast local resources are dedicated lines that allow the output of each tile to connect directly to every input of the eight surrounding tiles (Figure 4 on page 6).
The efficient long line resources provide routing for longer distances and higher fanout connections. These resources vary in length (spanning 1,2 , or 4 tiles), run both vertically and horizontally, and cover the entire ProASIC device (Figure 5 on page 6). Each tile can drive signals onto the efficient long line resources, while the resources can also access every input of any tile. The routing software automatically inserts active buffers to limit loading effects due to distance and fanout.

The high speed very long line resources, spanning across the entire device with minimal delay, are used to route very long or very high fanout nets. These resources run vertically
and horizontally, providing multiple access to each group of tiles throughout the device (Figure 6 on page 7).

The high performance global networks' clock trees are low skew, high fanout nets that are accessible from four dedicated pins or from internal logic (Figure 7 on page 8). These nets are typically used to distribute clocks, resets, and other high fanout nets requiring a minimum skew. The global networks are implemented as clock trees, and signals can be introduced at any junction. These can be employed hierarchically, with signals accessing every input on all tiles.

## Clock Resources

ProASIC's high-drive routing structure provides four global networks, each accessible from either a dedicated global pad or a logic tile. Global lines provide optimized worst-case clock skew of 0.3 ns .


Figure 4 • Ultra Fast Local Resources


Figure 5•Efficient Long Line Resources


Figure 6 • High Speed Very Long Line Resources

## Clock Trees

One of the main architectural benefits of ProASIC is the set of power and delay friendly global networks. The ProASIC family offers 4 global trees. Each of these trees is based on a network of spines and ribs that reach all the tiles in their regions (Figure 7). This flexible clock tree architecture allows users to map up to 56 different internal/external clocks in an A500K270 device (Table 1).

The flexible use of the ProASIC clock spine allows the designer to cope with several design requirements. Users implementing clock resource intensive applications can easily route external or gated internal clocks using global routing spines. Users can also drastically reduce delay penalties and save buffering resources by mapping critical high fanout nets to spines. For design hints on using these features, refer to the Efficient Use of ProASIC Clock Trees application note.


Figure 7 • A500K130 Global Routing Resources
Table 1 • Number of Clock Spines

|  | A500K050 | A500K130 | A500K180 | A500K270 |
| :--- | :---: | :---: | :---: | :---: |
| Top Spine Height | 24 | 32 | 40 | 56 |
| Tiles in Each Top Spine | 768 | 1,024 | 1,280 | 1,792 |
| Bottom Spine Height | 32 | 40 | 56 | 64 |
| Tiles in Each Bottom Spine | 1,024 | 1,280 | 1,792 | 2,048 |
| Global Clock Networks (Trees) | 4 | 4 | 4 | 4 |
| Clock Spines/Tree | 6 | 10 | 12 | 14 |
| Total Spines | 24 | 40 | 48 | 56 |
| Total Tiles | 5,376 | 12,800 | 18,432 | 26,880 |

## Input/Output Blocks

To meet complex system design needs, the ProASIC 500K family offers devices with a large number of I/0 pins, up to 440 user I/0 pins on the A 500 K 270 . If the I/0 pad is powered at 3.3 V , each I/0 can be selectively configured at 2.5 V and 3.3 V threshold levels. Table 2 shows the available supply voltage configurations. Figure 8 illustrates I/O interfaces with other devices.

Table 2 - ProASIC Power Supply Voltages

| $\mathrm{V}_{\text {DDP }}$ | $\mathbf{2 . 5 V}$ | 3.3 V |
| :--- | :--- | :---: |
| Input Tolerance | 2.5 V | $3.3 \mathrm{~V}, 2.5 \mathrm{~V}$ |
| Output Drive | 2.5 V | $3.3 \mathrm{~V}, 2.5 \mathrm{~V}$ |

Note: $V_{D D L}$ is always 2.5V.
The I/0 pads are fully configurable to provide the maximum flexibility and speed. Each pad can be configured as an input, an output, a three-state driver, or a bidirectional buffer (Figure 9). I/0 pads configured as inputs have the following features:

- Individually selectable 2.5 V or 3.3 V threshold levels ${ }^{1}$
- Optional pull-up resistor

I/O pads configured as outputs have the following features:

- Individually selectable 2.5 V or 3.3 V compliant output signals ${ }^{1}$
- 3.3V PCI compliant
- Ability to drive LVTTL and LVCMOS levels
- Selectable drive strengths
- Selectable slew rates
- Tristate

I/O pads configured as bidirectional buffers have the following features:

- Individually selectable 2.5 V or 3.3 V compliant output signals and threshold levels ${ }^{1}$
- 3.3V PCI compliant
- Optional pull-up resistor
- Selectable drive strengths
- Selectable slew rates
- Tristate

[^0]All I/Os also include an ESD protection circuit. Each I/0 is tested according to the following model:

- Human Body Model (HBM) (Per Mil Std 883 Method 3015)


Figure 8 - I/O Interfaces


Figure 9 - I/O Block Schematic Representation

## Boundary Scan

ProASIC devices are compatible with IEEE Standard 1149.1, which defines a set of hardware architecture and mechanisms for cost-effective board-level testing. The basic ProASIC boundary-scan logic circuit is composed of the TAP (test access port), TAP controller, test data registers, and instruction register (Figure 10 on page 10). This circuit supports all mandatory IEEE 1149.1 instructions (EXTEST, SAMPLE/PRELOAD and BYPASS), the optional IDCODE instructions and private instructions used for device programming and factory testing.
Each test section is accessed through the TAP, which has five associated pins: TCK (test clock input), TDI and TD0 (test data input and output), TMS (test mode selector) and TRST (test reset input). TMS, TDI, and TRST are equipped
with pull-up resistors to ensure proper operation when no input data is supplied to them. These pins are dedicated for boundary-scan test usage.
The TAP controller is a four-bit state machine ( 16 states) that operates as shown in Figure 11 on page 11. The '1's and ' 0 's represent the values that must be present at TMS at a rising edge of TCK for the given state transition to occur. IR and DR indicate that the instruction register or the data register is operating in that state.

The TAP controller receives two control inputs (TMS and TCK) and generates control and clock signals for the rest of the test logic architecture. On power up, the TAP controller enters the Test-Logic-Reset state. To guarantee a reset of the controller from any of the possible states, TMS must remain high for five TCK cycles. The TRST pin may also be used to asynchronously place the TAP controller in the Test-Logic-Reset state.
ProASIC devices support three types of test data registers: bypass, device identification, and boundary scan. The bypass
register is selected when no other register needs to be accessed in a device; this speeds up test data transfer to other devices in a test data path. The 32-bit device identification register is a shift register with four fields (LSB, ID number, part number and version). The boundary-scan register observes and controls the state of each I/0 pin.

Each I/O cell has three boundary-scan register cells, each with a serial-in, serial-out, parallel-in, and parallel-out pin. The serial pins are used to serially connect all the boundary-scan register cells in a device into a boundary scan register chain which starts at the TDI pin and ends at the TD0 pin. The parallel ports are connected to the internal core logic tile and the input, output, and control ports of an I/O buffer to capture and load data into the register to control or observe the logic state of each I/0.

Details on the implementation of boundary-scan testing on ProASIC devices can be found in the Actel application note, Using JTAG Boundary-Scan with ProASIC Devices.


Figure 10 • ProASIC JTAG Boundary Scan Test Logic Circuit

1


Figure 11 - TAP Controller State Diagram

## User Security

The ProASIC 500K devices have read-protect bits that, once programmed, lock the entire programmed contents from being read externally. The user can only reprogram the device using the security key. This protects it from being read back and duplicated. Since programmed data is stored in nonvolatile Flash cells (which act like very small capacitors), rather than in the wiring, physical deconstruction cannot be used to compromise data. That approach would be further hampered by the placement of the flash cells, beneath the four metal layers (whose removal could not be accomplished without disturbing the charge on the floating gate). This is the highest security provided in the industry. For more information, refer to the Design Security for Nonvolatile Flash and Antifuse FPGAs white paper for more information.

## Embedded Memory FloorpIan

The embedded memory is located across the top of the device (see Figure 1 on page 4) in 256 x 9 blocks. Depending upon the device, 6 to 28 blocks are available to support a variety of memory configurations. Each block can be programmed as an independent memory or combined (using dedicated memory routing resources) to form larger, more complex memories.

## Embedded Memory Configurations

The embedded memory in the ProASIC 500K family provides great configuration flexibility. While other programmable vendors typically use single port memories that can only be transformed into two-port memories by sacrificing half the memory, each ProASIC block is designed and optimized as a two-port memory ( 1 read, 1 write). This provides 63 k bits of total memory for two-port and single port usage in the A500K270 device.
Each memory can be configured as FIFO or SRAM, with independent selection of synchronous or asynchronous read and write ports (Table 3 on page 12). Multiple write ports are not supported. Additional characteristics include programmable flags as well as parity check and generation. Figure 12 and Figure 13 on page 13 show the block diagrams of the basic SRAM and FIFO blocks. These memories are designed to operate up to 133 MHz when operated individually. Each block contains a 256 word deep by 9 -bit wide ( 1 read, 1 write) memory. The memory blocks may be combined in parallel to form wider memories or stacked to form deeper memories (Figure 14 on page 14). This provides optimal bit widths of 9 ( 1 block), 18, 36, and 72, and optimal depths of $256,512,768$, and 1024 . Refer to the Macro Library Guide for more information.

Figure 15 on page 14 gives an example of optimal memory usage. Ten blocks with 23,040 bits have been used to generate three memories of various widths and depths. Figure 16 on page 14 shows how memory can be doubled up to create extra read ports. In this example, 10 out of 28
blocks of the A500K270 yield an effective 6,912 bits of multiple port memories. The ACTgen ${ }^{\mathrm{TM}}$ software facilitates building wider and deeper memories for optimal memory usage.

Table 3 - Basic Memory Configurations

| Type | Write Access | Read Access | Parity | Library Cell Name |
| :--- | :--- | :--- | :--- | :--- |
| RAM | Asynchronous | Asynchronous | Checked | RAM256x9AA |
| RAM | Asynchronous | Asynchronous | Generated | RAM256x9AAP |
| RAM | Asynchronous | Synchronous Transparent | Checked | RAM256xAST |
| RAM | Asynchronous | Synchronous Transparent | Generated | RAM256xASTP |
| RAM | Asynchronous | Synchronous Pipelined | Checked | RAM256x9ASR |
| RAM | Asynchronous | Synchronous Pipelined | Generated | RAM256x9ASRP |
| RAM | Synchronous | Asynchronous | Checked | RAM256x9SA |
| RAM | Synchronous | Asynchronous | Generated | RAM256xSAP |
| RAM | Synchronous | Synchronous Transparent | Checked | RAM256x9SST |
| RAM | Synchronous | Synchronous Transparent | Generated | RAM256x9SSTP |
| RAM | Synchronous | Synchronous Pipelined | Checked | RAM256x9SSR |
| RAM | Synchronous | Synchronous Pipelined | Generated | RAM256x9SSRP |
| FIFO | Asynchronous | Asynchronous | Checked | FIFO256xAA |
| FIFO | Asynchronous | Asynchronous | Generated | FIFO256x9AAP |
| FIFO | Asynchronous | Synchronous Transparent | Checked | FIFO256xAST |
| FIFO | Asynchronous | Synchronous Transparent | Generated | FIFO256x9ASTP |
| FIFO | Asynchronous | Synchronous Pipelined | Checked | FIFO256x9ASR |
| FIFO | Asynchronous | Synchronous Pipelined | Generated | FIFO256x9ASRP |
| FIFO | Synchronous | Asynchronous | Checked | FIFO256x9SA |
| FIFO | Synchronous | Asynchronous | Generated | FIFO256xSAP |
| FIFO | Synchronous | Synchronous Transparent | Checked | FIFO256x9SST |
| FIFO | Synchronous | Synchronous Transparent | Generated | FIFO256x9SSTP |
| FIFO | Synchronous | Synchronous Pipelined | Checked | FIFO256x9SSR |
| FIFO | Synchronous | Synchronous Pipelined | Generated | FIFO256x9SSRP |



Note: For memory block interface signal definitions, see Table 4 on page 28.
Figure 12 • Example SRAM Block Diagrams


Note: For memory block FIFO signal definitions, see Table 5 on page 34.
Figure 13 • Basic FIFO Block Diagrams
$\qquad$


Figure 14 • A500K270 Memory Block Architecture


1,024 words $x$ 9bits, 1 read, 1 write


256 words x 18bits, 1 read, 1 write

512 words $\times 18$ bits, 1 read, 1 write

Total Memory Blocks Used $=10$
Total Memory Bits $=23,040$
Figure 15 • Example Showing Memories with Different Width and Depth


Total Memory Blocks Used $=10$
Total Memory Bits $=6,912$
Figure 16 • Multiport Memory Usage

## Design Environment

ProASIC devices are supported by Actel's Designer Series software, as well as all of the industry standard third party CAE tools. Unlike other FPGA vendors, no special HDL instantiation or device related attributes are needed when using the standard VHDL or Verilog HDL design flow with ProASIC. As a result, designers can utilize the technology independent of HDL code for ProASIC devices. This feature and the ASIC-like design flow ensure a seamless transition to an ASIC implementation, if production volumes warrant a migration to a gate array or a standard cell product (Figure 17).

ACTgen automatically generates memories and FIFOs with all the various options (width, depth, access mode, parity checking or generation, flags, etc.). For a synchronous read port, the user can choose whether the output is pipelined or transparent. ACTgen allows any bit width up to 252 (for the A500K270 device). ACTgen also enables optimal memory stacking in 256 -word increments. However, any word depth may be combined for up to 7,168 words. ACTgen allows the user to generate distributed memory.

Place and route is performed by Actel's Designer software. Available for UNIX workstations and PC platforms, Designer software accepts standard netlists in Verilog, VHDL, and in EDIF format, performs timing driven place and route of the
design into the selected device/package, and provides postlayout timing information for backannotated simulation or static timing analysis. The Designer software also contains very powerful layout capabilities for the experienced user. A very comprehensive set of floor planning, timing, and routing constraints gives users optimal control over the tools' capabilities, enabling them to meet their tight design requirements. Users have access to constraints that allow them full control of the resources management. See the Designer User's Guide for various constraints and their uses.

The ProASIC devices are also fully supported by Actel's Libero design tool suite. Libero is a design management environment that integrates the needed design tools, streamlines the design flow, manages all design and log files, and passes the necessary design data between tools. Libero includes Synplify, ViewDraw, Actel's Designer Series, ModelSim HDL Simulator, and WaveFormer Lite.

Once the design is finalized, the programming bitstream is downloaded into the device programmer for ProASIC part programming. ProASIC 500K devices can be programmed with the Silicon Sculptor II and Flash Pro programmers. On-board programming is also available. Refer to the In-System Programming ProASIC 500K with Silicon Sculptor application note for more information.


Figure 17 • ProASIC Design Flow

## Package Thermal Characteristics

The ProASIC 500 K family is available in a number of package types. Actel has selected packages based on high pin count, reliability factors, and superior thermal characteristics.
Thermal resistance indicates the ability of a package to conduct heat away from the silicon, through the package, to the surrounding air. Junction-to-ambient thermal resistance is measured in degrees Celsius/Watt and is represented as Theta ja $\left(\Theta_{\mathrm{ja}}\right)$. The lower the thermal resistance, the more efficiently a package will dissipate heat.
A package's maximum allowed power ( P ) is a function of maximum junction temperature ( $\mathrm{T}_{\mathrm{J}}$ ), maximum ambient
operating temperature $\left(\mathrm{T}_{\mathrm{A}}\right)$, and junction-to-ambient thermal resistance $\Theta_{\mathrm{ja}}$. Maximum junction temperature is the maximum allowable temperature on the active surface of the IC and is $110^{\circ} \mathrm{C}$. P is defined as:

$$
P=\frac{T_{J}-T_{A}}{\Theta_{j a}}
$$

$\Theta_{\mathrm{ja}}$ is a function of the rate (in linear feet per minute lfpm) of airflow in contact with the package. When the estimated power consumption exceeds the maximum allowed power, other means of cooling, such as increasing the airflow rate, must be used.

| Package Type | Pin Count | $\Theta_{\text {jc }}$ | $\Theta_{\mathbf{j a}}$ Still Air | $\Theta_{\mathrm{ja}} \mathbf{3 0 0} \mathrm{ft} / \mathbf{m i n}$ | Units |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Plastic Quad Flat Pack (PQFP) | 208 | 8 | 30 | 23 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| PQFP with Heatspreader | 208 | 3.8 | 20 | 17 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Plastic Ball Grid Array (PBGA) | 272 | 3 | 20 | 16.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Plastic Ball Grid Array (PBGA) | 456 | 3 | 18 | 14.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Fine Ball Grid Array (FBGA) | 144 | 3.8 | 38.8 | 26.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Fine Ball Grid Array (FBGA) | 256 | 3.0 | 30 | 25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## Calculating Power Dissipation

ProASIC device power is calculated with both a static and an active component. The active component is a function of both the number of tiles utilized and the system speed. Power dissipation can be calculated using the following formula:

$$
\mathrm{P}_{\text {total }}=\mathrm{P}_{\mathrm{dc}}+\mathrm{P}_{\mathrm{ac}}
$$

where:
$\mathrm{P}_{\mathrm{dc}}=10 \mathrm{~mW}$
$\mathrm{P}_{\mathrm{ac}}=\mathrm{P}_{\text {clock }}+\mathrm{P}_{\text {storage }}+\mathrm{P}_{\text {logic }}+\mathrm{P}_{\text {ios }}+\mathrm{P}_{\text {memory }}$
$\mathrm{P}_{\text {clock }}=(\mathrm{P} 1+\mathrm{P} 2 * \mathrm{~s}) * \mathrm{Fs}$
where:
P1 $=2500 \mathrm{uW} / \mathrm{MHz}$
the basic power consumption of the clock-tree normalized per MHz of the clock
P2 $=1.0 \mathrm{uW} / \mathrm{MHz}$
the extra power consumption of the clock-tree per storage-tile normalized per MHz of the clock
$\mathrm{s}=$ the number of storage tiles clocked by this clock
Fs = the clock frequency

$$
\mathrm{P}_{\text {storage }}=\mathrm{P} 5 * \mathrm{~ms} * \mathrm{Fs}
$$

where:
P5 $=1.0 \mathrm{uW} / \mathrm{MHz}$
the average power consumption of a storage-tile normalized per MHz of its output
ms $=$ the number of storage tiles switching at each Fs cycle
Fs $=$ the clock frequency

$$
\mathrm{P}_{\mathrm{logic}}=\mathrm{P} 3 * \mathrm{mc} * \mathrm{Fs}
$$

where:
P3 $=3.0 \mathrm{uW} / \mathrm{MHz}$
the average power consumption of a logic-tile normalized per MHz of its output
$\mathrm{mc}=$ the number of logic tiles switching at each Fs cycle
Fs = the clock frequency

$$
\mathrm{P}_{\mathrm{ios}}=\left(\mathrm{P} 4+\mathrm{C}_{\text {load }} * \mathrm{~V}_{\mathrm{ddp}} \wedge 2\right) * \mathrm{p} * \mathrm{Fp}
$$

where:
$\mathrm{P} 4=15.0 \mathrm{uW} / \mathrm{MHz}$
the average power consumption of an output-pad normalized per MHz of its output (internal powerload is not included)
$\mathrm{C}_{\text {load }}=$ the output load
$\mathrm{p} \quad=$ the number of outputs
$\mathrm{Fp}=$ the average output frequency
$\mathrm{P}_{\text {memory }}=\mathrm{P} 6 * \mathrm{~N}_{\text {mem }} * \mathrm{~F}_{\text {mem }}$
where:
$\mathrm{P} 6=100.0 \mathrm{uW} / \mathrm{MHz}$ is the average power consumption of a memory block normalized per MHz of the clock
$\mathrm{N}_{\text {mem }}=$ the number of RAM/FIFO blocks ( 1 block $=256$ words * 9 bits)
$\mathrm{F}_{\mathrm{mem}}=$ the clock frequency of the memory
The following is an example using a shift register design with 13,440 storage tiles and 0 logic tile. This design has one clock at 10 MHz , and 24 outputs toggling at 5 MHz for a A500K270.

$$
\begin{aligned}
\mathrm{Fs}= & 10 \mathrm{MHz} \\
\mathrm{~s}= & 13,440 \\
& =>\quad \text { Pclock }=(\mathrm{P} 1+\mathrm{P} 2 * \mathrm{~s}) * \mathrm{Fs}=159.4 \mathrm{~mW}
\end{aligned}
$$

$\mathrm{ms}=13,440$ (in a shift register $100 \%$ of storage-tiles are toggling at each clock cycle and $\mathrm{Fs}=10 \mathrm{MHz}$

$$
=>\text { Pstorage }=\text { P5 } * \mathrm{~ms} * \mathrm{Fs}=134.4 \mathrm{~mW}
$$

$\mathrm{mc}=0$ (no logic tile in this shift-register)

$$
\Rightarrow \quad P_{\text {logic }}=0 \mathrm{~mW}
$$

$\mathrm{Fp}=5 \mathrm{MHz}$
$\mathrm{C}_{\text {load }}=40 \mathrm{pF}$
$\mathrm{V}_{\text {DDP }}=3.3 \mathrm{~V}$
and $\mathrm{p}=24$
$=>\quad \mathrm{P}_{\mathrm{ios}}=\left(\mathrm{P} 4+\mathrm{Cload}^{*} \mathrm{~V}_{\mathrm{ddp}}{ }^{\wedge} 2\right) * \mathrm{p} * \mathrm{Fp}=54.1 \mathrm{~mW}$
$\mathrm{N}_{\text {mem }}=0$ (no RAM/FIF0 in this shift-register)
$\Rightarrow \quad \mathrm{P}_{\text {memory }}=0 \mathrm{~mW}$

- $\mathrm{P}_{\mathrm{ac}}=\mathrm{P}_{\text {clock }}+\mathrm{P}_{\text {storage }}+\mathrm{P}_{\text {logic }}+\mathrm{P}_{\text {ios }}+\mathrm{P}_{\text {memory }}=347.9 \mathrm{~mW}$
- $\mathrm{P}_{\mathrm{dc}}=10 \mathrm{~mW}$
- $\mathrm{P}_{\text {total }}=\mathrm{P}_{\mathrm{dc}}+\mathrm{P}_{\mathrm{ac}}=357.9 \mathrm{~mW}$

Power Consumption of a 500K Device


## Operating Conditions

## Absolute Maximum Ratings

| Parameter | Condition | Minimum | Maximum | Units |
| :--- | :---: | :---: | :---: | :---: |
| Supply Voltage Core ( $\left.\mathrm{V}_{\mathrm{DDL}}\right)$ |  | -0.3 | 3.0 | V |
| Supply Voltage I/O Ring ( $\left.\mathrm{V}_{\mathrm{DDP}}\right)$ |  | -0.3 | 4.0 | V |
| DC Input Voltage |  | -0.3 | $\mathrm{~V}_{\mathrm{DDP}}+0.3$ | V |
| PCI DC Input Voltage |  | -0.5 | $\mathrm{~V}_{\mathrm{DDP}}+0.5$ | V |
| DC Input Clamp Current | $\mathrm{V}_{\mathrm{IN}<0 \text { or } \mathrm{V}_{\text {IN }}>\mathrm{V}_{\mathrm{DDP}}}$ | -10 | +10 | mA |

Note: $\quad$ Stresses beyond those listed in the Absolute Maximum Ratings table can cause permanent damage to the device. Exposure to maximum rated conditions for extended periods can adversely affect device reliability. Operation of the device at these conditions or any others beyond those listed in the Recommended Operating Conditions is not implied.

Programming and Storage Temperature LImits

| Product Grade | Programming <br> Cycles | Program <br> Retention | Storage Temperature |  |
| :--- | :---: | :---: | :---: | :---: |
|  |  |  | Max. |  |
| Commercial | 50 | 20 years | $-55^{\circ} \mathrm{C}$ | $110^{\circ} \mathrm{C}$ |
| Industrial | 50 | 20 years | $-55^{\circ} \mathrm{C}$ | $110^{\circ} \mathrm{C}$ |

## Supply Voltages

| Mode | $\mathbf{V}_{\text {DDL }}$ | $\mathbf{V}_{\text {DDP }}$ | $\mathbf{V}_{\text {PP }}$ | $\mathbf{V}_{\text {PN }}$ |
| :--- | :--- | :--- | :---: | :---: |
| Single Voltage | 2.5 V | 2.5 V | $2.5 \mathrm{~V} \leq \mathrm{V}_{\mathrm{pp}} \leq 16.5 \mathrm{~V}$ | $-12 \mathrm{~V} \leq \mathrm{V}_{\mathrm{PN}} \leq 0 \mathrm{~V}$ |
| Mixed Voltage | 2.5 V | 3.3 V | $3.3 \mathrm{~V} \leq \mathrm{V}_{\mathrm{pp}} \leq 16.5 \mathrm{~V}$ | $-12 \mathrm{~V} \leq \mathrm{V}_{\mathrm{PN}} \leq 0 \mathrm{~V}$ |

## Recommended Operating Conditions

| Parameter | Symbol | Limits |
| :--- | :---: | :---: |
| Commercial | $\mathrm{V}_{\mathrm{DDL}} \& \mathrm{~V}_{\mathrm{DDP}}$ | 2.3 V to 2.7 V |
| DC Supply Voltage (2.5V I/Os) | $\mathrm{V}_{\mathrm{DDP}}$ | 3.0 V to 3.6V |
| DC Supply Voltage (Mixed 2.5V and 3.3V I/Os) | $\mathrm{V}_{\mathrm{DDL}}$ | $\mathrm{T}_{\mathrm{A}}$ |
| Operating Ambient Temperature Range | $\mathrm{T}_{\mathrm{J}}$ | $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$ |
| Maximum Operating Junction Temperature | $\mathrm{f}_{\mathrm{CLOCK}}$ | $110^{\circ} \mathrm{C}$ |
| Maximum Clock Frequency | $\mathrm{f}_{\mathrm{RAM}}$ | 250 MHz |
| Maximum RAM Frequency |  | 150 MHz |
| Industrial | $\mathrm{V}_{\mathrm{DDL}} \& \mathrm{~V}_{\mathrm{DDP}}$ | 2.3 V to 2.7 V |
| DC Supply Voltage (2.5V I/Os) | $\mathrm{V}_{\mathrm{DDP}}$ | 3.0 V to 3.6 V |
| DC Supply Voltage (Mixed 2.5V and 3.3V I/Os) | $\mathrm{V}_{\mathrm{DDL}}$ | 2.3 V to 2.7 V |
| Operating Ambient Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |
| Maximum Operating Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | $110^{\circ} \mathrm{C}$ |
| Maximum Clock Frequency | $\mathrm{f}_{\mathrm{CLOCK}}$ | 250 MHz |
| Maximum RAM Frequency | $\mathrm{f}_{\mathrm{RAM}}$ | 150 MHz |

DC Electrical Specifications ( $\mathbf{V}_{\text {DDP }}=2.5 \mathrm{~V}$ )

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DDP }}, \mathrm{V}_{\text {DDL }}$ | Supply Voltage |  | 2.3 |  | 2.7 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Output High Voltage High Drive (OB25LPH) Low Drive (OB25LPL) | $\begin{aligned} & \mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-4.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-8.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-1.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-4.0 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.1 \\ & 2.0 \\ & 1.7 \\ & 2.1 \\ & 2.0 \\ & 1.7 \end{aligned}$ |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output Low Voltage High Drive (OB25LPH) Low Drive (OB25LPL) | $\begin{aligned} & \mathrm{l}_{\mathrm{OL}}=5.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=10.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=15.0 \mathrm{~mA} \\ & \mathrm{l}_{\mathrm{OL}}=2.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=3.5 \mathrm{~mA} \\ & \mathrm{l}_{\mathrm{OL}}=5.0 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.2 \\ & 0.4 \\ & 0.7 \\ & 0.2 \\ & 0.4 \\ & 0.7 \end{aligned}$ | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input High Voltage |  | 1.7 |  | $\mathrm{V}_{\text {DDP }}+0.3$ | V |
| $\mathrm{V}_{\text {IL }}$ | Input Low Voltage |  | -0.3 |  | 0.7 | V |
| $\left\|\mathrm{I}_{\text {IN }}\right\|^{2}$ | Input Current | with pull-up without pull-up | 25 |  | $\begin{gathered} 250 \\ 10 \end{gathered}$ | $\begin{gathered} \mu \mathrm{A} \\ \mu \mathrm{~A} \end{gathered}$ |
| $\mathrm{I}_{\text {DDQ }}$ | Quiescent Supply Current | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\text {SS }}{ }^{3}$ or $\mathrm{V}_{\text {DDL }}$ |  | 4.0 | 10 | mA |
| $\mathrm{I}_{\mathrm{Oz}}$ | 3-State Output Leakage Current | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{SS}}$ or $\mathrm{V}_{\mathrm{DDL}}$ |  |  | 10 | $\mu \mathrm{A}$ |
| $\|\mathrm{IOSH}\|^{2}$ | Output Short Circuit Current High High Drive (OB25LPH) Low Drive (OB25LPL) | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{SS}} \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{SS}} \end{aligned}$ |  |  | $\begin{aligned} & 120 \\ & 100 \end{aligned}$ | mA |
| lost | Output Short Circuit Current Low <br> High Drive (OB25LPH) <br> Low Drive (OB25LPL) | $\begin{aligned} & \mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DDP}} \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{DDP}} \end{aligned}$ |  |  | $\begin{gathered} 100 \\ 30 \end{gathered}$ | mA |
| $\mathrm{C}_{\text {I/O }}$ | I/O Pad Capacitance |  |  |  | 10 | pF |
| $\mathrm{C}_{\text {CLK }}$ | Clock Input Pad Capacitance |  |  |  | 10 | pF |

Notes:

1. All process conditions. Junction Temperature: -40 to $+110^{\circ} \mathrm{C}$.
2. Current is negative.
3. No pull-up resistor.

## DC Electrical Specifications ( $V_{\text {DDP }}=3.3 \mathrm{~V}$ )

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DDP }}$ | Supply Voltage |  | 3.0 |  | 3.6 | V |
| $\mathrm{V}_{\mathrm{DDL}}$ | Supply Voltage, Logic Array |  | 2.3 |  | 2.7 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Output High Voltage 3.3V I/O, High Drive (OB33P) <br> 3.3V I/O, Low Drive (OB33L) | $\begin{aligned} & \mathrm{l}_{\mathrm{OH}}=-5.0 \mathrm{~mA} \\ & \mathrm{IOH}_{\mathrm{OH}}=-10.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-2.5 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-5.0 \mathrm{~mA} \end{aligned}$ | $\begin{gathered} 0.9 \mathrm{~V}_{\mathrm{DDP}} \\ 2.4 \\ 0.9 \mathrm{~V}_{\mathrm{DDP}} \\ 2.4 \end{gathered}$ |  |  | V |
|  | Output High Voltage 2.5 V I/O, High Drive (OB25H) 2.5V I/O, Low Drive (OB25L) | $\begin{aligned} & \mathrm{l}_{\mathrm{OH}}=-200 \mu \mathrm{~A} \\ & \mathrm{l}_{\mathrm{OH}}=-10.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA} \\ & \mathrm{l}_{\mathrm{OH}}=-100 \mu \mathrm{~A} \\ & \mathrm{l}_{\mathrm{OH}}=-1.0 \mathrm{~mA} \\ & \mathrm{l}_{\mathrm{OH}}=-2.0 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 2.1 \\ & 2.0 \\ & 1.7 \\ & 2.1 \\ & 2.0 \\ & 1.7 \end{aligned}$ |  |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output High Voltage 3.3V I/O, High Drive (OB33P) 3.3V I/O, Low Drive (OB33L) | $\begin{aligned} & \mathrm{l}_{\mathrm{OL}}=7.5 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=12.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=4.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{gathered} 0.1 \mathrm{~V}_{\mathrm{DDP}} \\ 0.4 \\ \\ 0.1 \mathrm{~V}_{\mathrm{DDP}} \\ 0.4 \end{gathered}$ | V |
|  | Output High Voltage 2.5V I/O, High Drive (OB25H) 2.5V I/O, Low Drive (OB25L) | $\begin{aligned} & \mathrm{l}_{\mathrm{OL}}=5.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=12.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=16.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=2.5 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=5.0 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OL}}=8.0 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.2 \\ & 0.4 \\ & 0.7 \\ & 0.2 \\ & 0.4 \\ & 0.7 \end{aligned}$ | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input High Voltage <br> 3.3V LVTTL/LVCMOS <br> 2.5V Mode |  | $\begin{gathered} 2 \\ 1.7 \end{gathered}$ |  | $\begin{aligned} & \mathrm{V}_{\mathrm{DDP}}+0.3 \\ & \mathrm{~V}_{\mathrm{DDP}}+0.3 \end{aligned}$ | V |
| VIL | Input Low Voltage 3.3V LVTTL/LVCMOS 2.5V Mode |  | $\begin{aligned} & -0.3 \\ & -0.3 \end{aligned}$ |  | $\begin{aligned} & 0.8 \\ & 0.7 \end{aligned}$ | V |
| $\left\|\mathrm{I}_{\mathrm{I}}\right\|^{2}$ | Input Current <br> LVTTL/LVCMOS <br> LVTTL/LVCMOS | with pull-up without pull-up | 30 |  | $\begin{gathered} 300 \\ 10 \end{gathered}$ | $\begin{gathered} \mu \mathrm{A} \\ \mu \mathrm{~A} \end{gathered}$ |
| DDQ | Quiescent Supply Current | $\mathrm{V}_{\mathrm{IN}}=\mathrm{V}_{\mathrm{SS}}{ }^{3}$ or $\mathrm{V}_{\mathrm{DDL}}$ |  | 4.0 | 10 | mA |
| $\mathrm{I}_{\text {DDQ }}{ }^{4}$ | Incremental Quiescent Supply Current |  |  | 70 | 400 | $\mu \mathrm{A}$ |
| loz | 3-State Output Leakage Current | $\mathrm{V}_{\mathrm{OH}}=\mathrm{V}_{\mathrm{SS}}$ or $\mathrm{V}_{\mathrm{DDL}}$ |  |  | 10 | $\mu \mathrm{A}$ |

Notes:

1. All process conditions. Junction Temperature: -40 to $+110^{\circ} \mathrm{C}$.
2. Current is negative.
3. No pull-up resistor.
4. $I_{D D Q}$ is augmented by $I_{D D Q I}$ for each 2.5V I/O when operating in a mixed voltage environment.

DC Electrical Specifications ( $\left.V_{\text {DDP }}=3.3 V\right)$ (Continued)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\|\mathrm{IOSH}\|^{2}$ | Output Short Circuit Current High <br> 3.3V High Drive <br> 3.3 Low Drive <br> 2.5V High Drive <br> 2.5 Low Drive |  |  |  | $\begin{aligned} & 200 \\ & 140 \\ & 120 \\ & 100 \end{aligned}$ | mA |
| lost | Output Short Circuit Current Low <br> 3.3V High Drive <br> 3.3 Low Drive <br> 2.5V High Drive <br> 2.5 Low Drive |  |  |  | $\begin{gathered} 160 \\ 150 \\ 160 \\ 50 \end{gathered}$ | mA |
| $\mathrm{C}_{\text {l/ }}$ | I/O Pad Capacitance |  |  |  | 10 | pF |
| $\mathrm{C}_{\text {CLK }}$ | Clock Input Pad Capacitance |  |  |  | 10 | pF |

Notes:

1. All process conditions. Junction Temperature: -40 to $+110^{\circ} \mathrm{C}$.
2. Current is negative.
3. No pull-up resistor.
4. $I_{\text {DDQ }}$ is augmented by $I_{\text {DDQI }}$ for each 2.5 V I/O when operating in a mixed voltage environment.

DC Specifications (3.3V PCI Operation)

| Symbol | Parameter | Condition | Min. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| V DDL | Supply Voltage for Core |  | 2.3 | 2.7 | V |
| $\mathrm{V}_{\text {DDP }}$ | Supply Voltage for I/O Ring |  | 3.0 | 3.6 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input High Voltage |  | $0.5 \mathrm{~V}_{\text {DPP }}$ | $\mathrm{V}_{\text {DPP }}+0.5$ | V |
| $\mathrm{V}_{\text {IL }}$ | Input Low Voltage |  | -0.5 | $0.3 \mathrm{~V}_{\text {DDP }}$ | V |
| IIPU | Input Pull-up Voltage ${ }^{1}$ |  | $0.7 \mathrm{~V}_{\text {DDP }}$ |  | V |
| $\mathrm{I}_{\text {IL }}$ | Input Leakage Current ${ }^{2}$ | $0<\mathrm{V}_{\mathrm{IN}}<\mathrm{V}_{\mathrm{CCI}}$ | -10 | +10 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\mathrm{OH}}$ | Output High Voltage | $\mathrm{I}_{\text {OUT }}=-500 \mu \mathrm{~A}$ | $0.9 \mathrm{~V}_{\text {DPP }}$ |  | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Output Low Voltage | $\mathrm{I}_{\text {OUT }}=1500 \mu \mathrm{~A}$ |  | $0.1 \mathrm{~V}_{\text {DPP }}$ | V |
| $\mathrm{C}_{\text {IN }}$ | Input Pin Capacitance ${ }^{3}$ |  |  | 10 | pF |
| $\mathrm{C}_{\text {CLK }}$ | CLK Pin Capacitance |  | 5 | 12 | pF |

## Notes:

1. This specification should be guaranteed by design. It is the minimum voltage to which pull-up resistors are calculated to pull a floated network. Applications sensitive to static power utilization should assure that the input buffer is conducting minimum current at this input voltage.
2. Input leakage currents include hi-Z output leakage for all bidirectional buffers with tristate outputs.
3. Absolute maximum pin capacitance for a PCI input is 10 pF (except for CLK).

## AC Specifications (3.3V PCI Operation)

| Symbol | Parameter | Condition | Min. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{IOH}_{(A C)}$ | Switching Current High | $0<\mathrm{V}_{\text {OUT }} \leq 0.3 \mathrm{~V}_{\text {CCI }}{ }^{1}$ | $-12 \mathrm{~V}_{\mathrm{CCI}}$ |  | mA |
|  |  | $0.3 \mathrm{~V}_{\mathrm{CCI}} \leq \mathrm{V}_{\text {OUT }}<0.9 \mathrm{~V}_{\mathrm{CCI}}{ }^{1}$ | $\left(-17.1+\left(\mathrm{V}_{\text {DDP }}-\mathrm{V}_{\text {OUT }}\right)\right)$ |  | mA |
|  |  | $0.7 \mathrm{~V}_{\mathrm{CCI}}<\mathrm{V}_{\text {OUT }}<\mathrm{V}_{\mathrm{CCI}}{ }^{1,2}$ |  | Equation A on page 23 |  |
|  | (Test Point) | $\mathrm{V}_{\text {OUT }}=0.7 \mathrm{~V}_{\text {CC }}{ }^{2}$ |  | $-32 \mathrm{~V}_{\mathrm{CCI}}$ | mA |
| $\mathrm{I}_{\text {OL(AC) }}$ | Switching Current Low | $\mathrm{V}_{\text {CCI }}>\mathrm{V}_{\text {OUT }} \geq 0.6 \mathrm{~V}_{\text {CCI }}{ }^{1}$ | $16 \mathrm{~V}_{\text {DDP }}$ |  | mA |
|  |  | $0.6 \mathrm{~V}_{\mathrm{CCI}}>\mathrm{V}_{\text {OUT }}>0.1 \mathrm{~V}_{\mathrm{CCI}}{ }^{1}$ | (26.7V $\mathrm{V}_{\text {OUT }}$ ) |  | mA |
|  |  | $0.18 \mathrm{~V}_{\mathrm{CCI}}>\mathrm{V}_{\text {OUT }}>0^{1,2}$ |  | Equation B on page 23 |  |
|  | (Test Point) | $\mathrm{V}_{\text {OUT }}=0.18 \mathrm{~V}_{\text {CC }}{ }^{2}$ |  | $38 \mathrm{~V}_{\text {CCI }}$ | mA |
| $\mathrm{I}_{\mathrm{CL}}$ | Low Clamp Current | $-3<\mathrm{V}_{\text {IN }} \leq-1$ | $-25+\left(V_{\text {IN }}+1\right) / 0.015$ |  | mA |
| $\mathrm{I}_{\mathrm{CH}}$ | High Clamp Current | $\mathrm{V}_{\mathrm{CCI}}+4>\mathrm{V}_{\text {IN }} \geq \mathrm{V}_{\mathrm{CCI}}+1$ | $25+\left(\mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {DDP }}-1\right) / 0.015$ |  | mA |
| slew $_{\text {R }}$ | Output Rise Slew Rate | $0.2 \mathrm{~V}_{\mathrm{CCI}}$ to $0.6 \mathrm{~V}_{\mathrm{CCI}}$ load $^{3}$ | 1 | 4 | $\mathrm{V} / \mathrm{ns}$ |
| slew $_{\text {F }}$ | Output Fall Slew Rate | $0.6 \mathrm{~V}_{\mathrm{CCI}}$ to $0.2 \mathrm{~V}_{\mathrm{CCI}}$ load $^{3}$ | 1 | 4 | V/ns |

## Notes:

1. Refer to the V/I curves in Figure 18 on page 23. Switching current characteristics for REQ\# and GNT\# are permitted to be one half of that specified here; i.e., half size output drivers may be used on these signals. This specification does not apply to CLK and RST\#, which are system outputs. "Switching Current High" specifications are not relevant to SERR\#, INTA\#, INTB\#, INTC\#, and INTD\#, which are open drain outputs.
2. Maximum current requirements must be met as drivers pull beyond the last step voltage. Equations defining these maximums ( $A$ and B) are provided with the respective diagrams in Figure 18 on page 23. The equation defined maxima should be met by design. In order to facilitate component testing, a maximum current test point is defined for each side of the output driver.
3. This parameter is to be interpreted as the cumulative edge rate across the specified range, rather than the instantaneous rate at any point within the transition range. The specified load (diagram below) is optional; i.e., the designer may elect to meet this parameter with an unloaded output per the latest revision of the PCI Local Bus Specification. However, adherence to both maximum and minimum parameters is required (the maximum is no longer simply a guideline). Rise slew rate does not apply to open drain outputs.


Figure 18 shows the 3.3 V PCI V/I curve and the minimum and maximum PCI drive characteristics of the ProASIC family.


Figure 18 • 3.3V PCI V/I Curve for ProASIC Family

## Equation A

$$
\begin{gathered}
\mathrm{I}_{\text {OH }}=\left(98.0 / \mathrm{V}_{\mathrm{CCI}}\right) *\left(\mathrm{~V}_{\text {OUT }}-\mathrm{V}_{\mathrm{CCI}}\right) *\left(\mathrm{~V}_{\text {OUT }}+0.4 \mathrm{~V}_{\mathrm{CCI}}\right) \\
\text { for } 0.7 \mathrm{~V}_{\text {CCI }}<\mathrm{V}_{\text {OUT }}<\mathrm{V}_{\text {CCI }}
\end{gathered}
$$

## Timing Characteristics

Timing characteristics for ProASIC 500K devices fall into three categories: family dependent, device dependent, and design-dependent. The input and output buffer characteristics are common to all ProASIC 500 K family members. Internal routing delays are device-dependent. Design dependency means that actual delays are not determined until after placement and routing of the user's design are completed. Design timing attributes may then be determined by using Timer, the Static Analysis tool embedded into Designer software, or performing simulation with post-layout delays using ModelSim Simulator integrated into Libero design environment.

## Critical Nets and Typical Nets

Propagation delays are expressed only for typical nets, which are used for initial design performance evaluation. Critical net delays can then be applied to the most critical timing paths. Critical nets are determined by net property assignment prior to placement and routing. Up to 6 percent of the nets in a design may be designated as critical, while more than $90 \%$ of the nets in a design are typical. User's can control priorities between critical nets and use routing constraints, such as set_critical to focus the routing optimization on the most critical ones. Please see the Designer User's Guide for more information on using constraints.

Equation $B$

$$
\begin{gathered}
\mathrm{I}_{0 \mathrm{~L}}=\left(256 / \mathrm{V}_{\mathrm{CCI}}\right) * \mathrm{~V}_{\text {OUT }} *\left(\mathrm{~V}_{\mathrm{CCI}}-\mathrm{V}_{\text {OUT }}\right) \\
\text { for } 0 \mathrm{~V}<\mathrm{V}_{\text {OUT }}<0.18 \mathrm{~V}_{\text {CCI }}
\end{gathered}
$$

## Very Long Lines

Some nets in the design are very long lines marked using VLLs, which are special routing resources that span multiple rows, columns, or modules. This increases capacitance and resistance, resulting in longer net delays for macros connected to long tracks. Typically, up to 6 percent of nets in a fully utilized device require long tracks. Very long lines contribute between 4 and 8.4 ns routing delay depending on the fanout. This additional delay is represented statistically in higher fanout routing delays.

## Timing Derating

Since ProASIC 500K devices are manufactured with a CMOS process, device performance will vary with temperature, voltage, and process. Minimum timing parameters reflect maximum operating voltage, minimum operating temperature, and optimal process variations. Maximum timing parameters reflect minimum operating voltage, maximum operating temperature, and worst-case process variations (within process specifications).

Temperature and Voltage Derating Factors
(Normalized to Worst-Case Commercial, $\mathbf{T}_{\mathbf{J}}=\mathbf{7 0}{ }^{\circ} \mathrm{C}, \mathbf{V}_{\mathbf{c c A}}=2.3 \mathrm{~V}$ )

|  | $\mathbf{V}_{\text {CCA }}$ |  |  |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Slew Rates Measured at $C_{\text {out }}=10 p F$ (Total Output Load), Nominal Power Supplies and $25^{\circ} C$

| Type | Trig. Lev. | Rising Edge | Slew Rate | Falling Edge | Slew Rate |
| :--- | :---: | :---: | :---: | :---: | :---: |
|  |  | pS | V/ns | pS | V/ns |
| OB33PH | $20 \%-60 \%$ | 397 | 3.33 | 390 | -3.38 |
| OB33PN | $20 \%-60 \%$ | 463 | 2.85 | 450 | -2.93 |
| OB33PL | $20 \%-60 \%$ | 567 | 2.33 | 527 | -2.51 |
| OB33LH | $20 \%-60 \%$ | 467 | 2.83 | 700 | -1.89 |
| OB33LN | $20 \%-60 \%$ | 620 | 2.13 | 767 | -1.72 |
| OB33LL | $20 \%-60 \%$ | 813 | 1.62 | 1100 | -1.20 |
| OB25HH | $20 \%-60 \%$ | 750 | 1.33 | 310 | -3.23 |
| OB25HN | $20 \%-60 \%$ | 850 | 1.18 | 390 | -2.56 |
| OB25HL | $20 \%-60 \%$ | 1310 | 0.76 | 510 | -1.96 |
| OB25LH | $20 \%-60 \%$ | 793 | 1.26 | 430 | -2.33 |
| OB25LN | $20 \%-60 \%$ | 870 | 1.15 | 730 | -1.37 |
| OB25LL | $20 \%-60 \%$ | 1287 | 0.78 | 1037 | -0.96 |
| OB25LPHH | $20 \%-60 \%$ | 470 | 2.13 | 433 | -2.31 |
| OB25LPHN | $20 \%-60 \%$ | 533 | 1.81 | 527 | -1.90 |
| OB25LPHL | $20 \%-60 \%$ | 770 | 1.30 | 753 | -1.33 |
| OB25LPLH | $20 \%-60 \%$ | 597 | 1.68 | 707 | -1.42 |
| OB25LPLN | $20 \%-60 \%$ | 873 | 1.15 | 760 | -1.32 |
| OB25LPLL | $20 \%-60 \%$ | 1153 | 0.87 | 1563 | -0.54 |

## Tristate Buffer Delays



Tristate Buffer Delays


| Macro Type | Description | $\begin{gathered} \operatorname{Max} \\ \mathbf{t}_{\mathrm{DLH}} \end{gathered}$ | $\begin{aligned} & \text { Max } \\ & \mathbf{t}_{\mathrm{DHL}} \end{aligned}$ | $\stackrel{\text { Max }}{\mathbf{t}_{\mathrm{ENZH}}}$ | $\begin{gathered} \max _{\mathbf{t}_{\mathrm{ENZL}}} \end{gathered}$ | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OTB33PH | $3.3 \mathrm{~V}, \mathrm{PCI}$ Output Current, High Slew Rate | 4.2 | 4.1 | 4.2 | 3.67 | ns |
| OTB33PN | 3.3V, PCI Output Current, Nominal Slew Rate | 4.7 | 5.9 | 4.8 | 5.3 | ns |
| OTB33PL | 3.3V, PCI Output Current, Low Slew Rate | 5.3 | 7.0 | 5.3 | 6.6 | ns |
| OTB33LH | 3.3V, Low Output Current, High Slew Rate | 6.0 | 6.6 | 6.0 | 5.9 | ns |
| OTB33LN | 3.3V, Low Output Current, Nominal Slew Rate | 6.7 | 9.2 | 6.7 | 8.9 | ns |
| OTB33LL | 3.3V, Low Output Current, Low Slew Rate | 7.5 | 12.0 | 7.5 | 11.8 | ns |
| OTB25HH | 2.5V, High Output Current, High Slew Rate | 6.9 | 3.6 | 6.9 | 3.4 | ns |
| OTB25HN | 2.5 V , High Output Current, Nominal Slew Rate | 7.2 | 5.2 | 7.2 | 4.9 | ns |
| OTB25HL | 2.5 V , High Output Current, Low Slew Rate | 8.2 | 6.4 | 8.2 | 6.1 | ns |
| OTB25LH | 2.5 V , Low Output Current, High Slew Rate | 10.4 | 5.5 | 10.4 | 5.2 | ns |
| OTB25LN | 2.5V, Low Output Current, Nominal Slew Rate | 11.0 | 8.3 | 11.0 | 8.1 | ns |
| OTB25LL | 2.5V, Low Output Current, Low Slew Rate | 11.9 | 10.9 | 11.9 | 11.7 | ns |
| OTB25LPHH | 2.5V, Low Power, High Output Current, High Slew Rate | 5.1 | 5.1 | 5.1 | 4.4 | ns |
| OTB25LPHN | 2.5V, Low Power, High Output Current, Nominal Slew Rate | 6.0 | 7.7 | 6.0 | 7.4 | ns |
| OTB25LPHL | 2.5V, Low Power, High Output Current, Low Slew Rate | 6.9 | 9.8 | 6.8 | 9.3 | ns |
| OTB25LPLH | 2.5V, Low Power, Low Output Current, High Slew Rate | 7.4 | 8.6 | 7.4 | 7.8 | ns |
| OTB25LPLN | 2.5V, Low Power, Low Output Current, Nominal Slew Rate | 8.6 | 12.6 | 8.5 | 12.3 | ns |
| OTB25LPLL | 2.5V, Low Power, Low Output Current, Low Slew Rate | 9.8 | 17.0 | 9.8 | 16.7 | ns |

## Notes:

1. $\quad t_{D L H}=$ Data-to-Pad HIGH
2. $t_{D H L}=$ Data-to-Pad LOW
3. $t_{E N Z H}=$ Enable-to-Pad, Z to HIGH
4. $t_{E N Z L}=$ Enable-to-Pad, Z to LOW

## Output Buffer Delays




ProASIC ${ }^{\text {TM }} \mathbf{5 0 0 K}$ Family

## Output Buffer Delays <br> 

| Macro Type | Description | Max. $\mathbf{t}_{\text {LLH }}$ | Max. $\mathbf{t}_{\text {DHL }}$ | Units |
| :--- | :--- | :---: | :---: | :---: |
| OB33PH | 3.3V, PCI Output Current, High Slew Rate | 4.2 | 4.1 | ns |
| OB33PN | 3.3V, PCI Output Current, Nominal Slew Rate | 4.7 | 5.9 | ns |
| OB33PL | 3.3V, PCI Output Current, Low Slew Rate | 5.3 | 7.1 | ns |
| OB33LH | 3.3V, Low Output Current, High Slew Rate | 6.0 | 6.6 | ns |
| OB33LN | 3.3V, Low Output Current, Nominal Slew Rate | 6.7 | 9.2 | ns |
| OB33LL | 3.3V, Low Output Current, Low Slew Rate | 7.5 | 12.1 | ns |
| OB25HH | 2.5V, High Output Current, High Slew Rate | 6.9 | 3.6 | ns |
| OB25HN | 2.5V, High Output Current, Nominal Slew Rate | 7.2 | 5.2 | ns |
| OB25HL | 2.5V, High Output Current, Low Slew Rate | 8.2 | 6.4 | ns |
| OB25LH | 2.5V, Low Output Current, High Slew Rate | 10.4 | 5.5 | ns |
| OB25LN | 2.5V, Low Output Current, Nominal Slew Rate | 11.0 | 8.3 | ns |
| OB25LL | 2.5V, Low Output Current, Low Slew Rate | 11.9 | 10.9 | ns |
| OB25LPHH | 2.5V, Low Power, High Output Current, High Slew Rate | 5.1 | 5.1 | ns |
| OB25LPHN | 2.5V, Low Power, High Output Current, Nominal Slew Rate | 6.0 | 7.7 | ns |
| OB25LPHL | 2.5V, Low Power, High Output Current, Low Slew Rate | 6.9 | 9.8 | ns |
| OB25LPLH | 2.5V, Low Power, Low Output Current, High Slew Rate | 7.4 | 8.6 | ns |
| OB25LPLN | 2.5V, Low Power, Low Output Current, Nominal Slew Rate | 8.6 | 12.6 | ns |
| OB25LPLL | 2.5V, Low Power, Low Output Current, Low Slew Rate | 9.8 | 17.0 | ns |

Notes:

1. $t_{\text {DLH }}=$ Data-to-Pad HIGH
2. $t_{D H L}=$ Data-to-Pad LOW

## Input Buffer Delays

|  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Input Buffer Delays <br> (Worst-Case Commercial Conditions, $V_{\text {DDP }}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDL}}=2.3 \mathrm{~V}, \mathrm{~T}_{\mathbf{J}}=\mathbf{7 0}{ }^{\circ} \mathbf{C}, \mathbf{f}_{\mathbf{C L O C K}}=250 \mathrm{MHz}$ ) |  |  |  |  |
| Macro Type | Description | Max. <br> $\mathrm{t}_{\mathrm{INYH}}$ | Max. <br> tinys | Units |
| IB25 | 2.5V, CMOS Input Levels, No Pull-up Resistor <br> 2.5V, CMOS Input Levels, Low Power | 2.2 | 0.7 | ns |
| IB25LP |  | 2.2 | 1.4 | ns |
| IB33 |  | 1.9 | 1.0 | ns |

Notes:

1. $t_{\text {INYH }}=$ Input Pad-to-Y HIGH
2. $t_{\text {INYL }}=$ Input Pad-to-Y LOW

Global Input Buffer Delays
(Worst-Case Commercial Conditions, $V_{\text {DDP }}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDL}}=2.3 \mathrm{~V}, \mathrm{~T}_{\mathbf{J}}=\mathbf{7 0} 0^{\circ} \mathrm{C}, \mathbf{f}_{\mathbf{c L o c k}}=250 \mathrm{MHz}$ )

| Macro Type | Description | Max. <br> $\mathbf{t}_{\mathbf{I N H}}$ | Max. <br> $\mathbf{t}_{\text {INYL }}$ | Units |
| :--- | :--- | :--- | :---: | :---: |
| GL25 | 2.5 V, CMOS Input Levels | 2.1 | 1.6 | ns |
| GL25LP | 2.5 V, CMOS Input Levels | 2.3 | 2.3 | ns |
| GL33 | 3.3 V, CMOS Input Levels | 3.8 | 1.2 | ns |
| GL25U | 2.5 V, CMOS Input Levels, with Pull-up Resistor | 2.1 | 1.6 | ns |
| GL25LPU | 2.5 V, CMOS Input Levels, Low Power, with Pull-up Resistor | 2.3 | 2.3 | ns |
| GL33U | 3.3 V, CMOS Input Levels, with Pull-up Resistor | 3.8 | 1.2 | ns |

## Predicted Global Routing Delay*



| Parameter | Description | Max. | Units |
| :--- | :--- | :---: | :---: |
| $t_{\text {RCKH }}$ | Input Low to High (fully loaded row—32 inputs) | 1.2 | ns |
| $t_{\text {RCKL }}$ | Input High to Low (fully loaded row-32 inputs) | 1.1 | ns |
| $t_{\text {RCKH }}$ | Input Low to High (minimally loaded row-1 input) | 0.9 | ns |
| $t_{\text {RCKL }}$ | Input High to Low (minimally loaded row-1 input) | 0.9 | ns |

* The timing delay difference between tile locations is less than 15ps.


## Global Routing Skew



| Parameter | Description | Max. | Units |
| :--- | :--- | :---: | :---: |
| $t_{\text {RCKSWH }}$ | Maximum Skew Low to High | 0.3 | ns |
| $\mathrm{t}_{\text {RCKSH }}$ | Maximum Skew High to Low | 0.3 | ns |

## Module Delays



## Sample Macrocell Library Listing (Worst-Case Commercial Conditions, $V_{\text {DDL }}=2.3 \mathrm{~V}, \mathbf{T}_{\mathbf{J}}=70^{\circ} \mathrm{C}$ )

| Cell Name | Description | Maximum <br> Intrinsic Delay | Minimum <br> Setup/Hold | Units |
| :--- | :--- | :---: | :---: | :---: |
| NAND2 | 2-Input NAND | 0.4 |  | ns |
| AND2 | 2-Input AND | 0.4 |  | ns |
| NOR3 | 3-Input NOR | 0.4 |  | ns |
| MUX2L | 2-1 Mux with Active Low Select | 0.4 |  | ns |
| OA21 | 2-Input OR into a 2-Input AND | 0.4 |  | ns |
| XOR2 | 2-Input Exclusive OR | 0.3 |  | ns |
| LDL | Active Low Latch (LH/HL) | D: $0.3 / 0.2$ | $\mathrm{t}_{\text {setup }} 0.5$ | ns |
|  |  |  | $t_{\text {hold }} 0.2$ |  |
| DFFL | Negative Edge-Triggered D-type Flip-Flop (LH/HL) | CLK-Q: | $\mathrm{t}_{\text {setup }} 0.4$ | ns |
|  |  | $0.4 / 0.4$ | $t_{\text {hold }} 0.2$ | ns |

Note: Assumes fanout of two.

## Embedded Memory Specifications

This section focuses on the embedded memory of the ProASIC 500 K family. It describes the SRAM and FIFO interface signals and includes timing diagrams that show the relationships of signals as they pertain to single embedded memory blocks (Table 4 and Table 5 on page 34). Refer to Table 3 on page 12 for basic RAM configurations. Simultaneous Read and Write to the same location must be done with care. On such accesses the DI bus is output to the D0 bus.

## Enclosed Timing Diagrams-SRAM Mode:

- Synchronous RAM Read, Access Timed Output Strobe (Synchronous Transparent)
- Synchronous RAM Read, Pipeline Mode Outputs
(Synchronous Pipelined)
- Asynchronous RAM Write
- Asynchronous RAM Read, Address Controlled, RDB=0
- Asynchronous RAM Read, RDB Controlled
- Synchronous RAM Write

Note: The difference between synchronous transparent and pipeline modes is the timing of all the output signals from the memory. In transparent mode the outputs will change within the same clock cycle to reflect the data requested by the currently valid access to the memory. However, if clock cycles are short (high clock speed), the data requires most of the clock cycle to change to valid values (stable signals). This makes processing of this data in the same clock cycle nearly impossible. Most designers solve this problem by adding registers at all outputs of the memory to push the data processing into the next clock cycle. In this setup, the whole cycle time can be used to process the data. To simplify the use of this kind of memory setup these registers have been implemented as part of the memory primitive and are available to the user in the synchronous pipeline mode. In this mode, the output signals will change shortly after the second rising edge, following the initiation of the read access.

Table 4 • Memory Block SRAM Interface Signals

| SRAM Signal | Bits | In/Out | Description |
| :--- | :---: | :---: | :--- |
| WCLKS | 1 | IN | Write clock used on synchronization on write side |
| RCLKS | 1 | IN | Read clock used on synchronization on read side |
| RADDR $<0: 7>$ | 8 | IN | Read address |
| RBLKB | 1 | IN | Negative true read block select |
| RDB | 1 | IN | Negative true read pulse |
| WADDR $<0: 7>$ | 8 | IN | Write address |
| WBLKB | 1 | IN | Negative true write block select |
| DI<0:8> | 9 | IN | Input data bits $<0: 8>,<8>$ can be used for parity in |
| WRB | 1 | IN | Negative true write pulse |
| DO<0:8> | 9 | OUT | Output data bits $<0: 8>,<8>$ can be used for parity out |
| RPE | 1 | OUT | Read parity error |
| WPE | 1 | OUT | Write parity error |
| PARODD | 1 | IN | Selects odd parity generation/detect when high, even when low |

Note: Not all signals shown are used in all modes.

## Synchronous RAM Read, Access Timed Output Strobe (Synchronous Transparent)


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol t $\mathbf{x x x}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| CCYC | Cycle time | 7.5 |  | ns |  |
| CMH | Clock high phase | 3.0 |  | ns |  |
| CML | Clock low phase | 3.0 |  | ns |  |
| OCA | New DO access from RCLKS $\uparrow$ | 7.5 |  | ns |  |
| OCH | Old DO valid from RCLKS $\uparrow$ |  | 3.0 | ns |  |
| RACH | RADDR hold from RCLKS $\uparrow$ | 0.5 |  | ns |  |
| RACS | RADDR setup to RCLKS $\uparrow$ | 1.0 |  | ns |  |
| RDCH | RDB hold from RCLKS $\uparrow$ | 0.5 |  | ns |  |
| RDCS | RDB setup to RCLKS $\uparrow$ | 1.0 |  | ns |  |
| RPCA | New RPE access from RCLKS $\uparrow$ | 9.5 |  | ns |  |
| RPCH | Old RPE valid from RCLKS $\uparrow$ |  | 3.0 | ns |  |

## Synchronous RAM Read, Pipeline Mode Outputs (Synchronous Pipelined)


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol t $\mathbf{x x x ~}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| CCYC | Cycle time | 7.5 |  | ns |  |
| CMH | Clock high phase | 3.0 |  | ns |  |
| CML | Clock low phase | 3.0 |  | ns |  |
| OCA | New DO access from RCLKS $\uparrow$ | 2.0 |  | ns |  |
| OCH | Old DO valid from RCLKS $\uparrow$ |  | .75 | ns |  |
| RACH | RADDR hold from RCLKS $\uparrow$ | 0.5 |  | ns |  |
| RACS | RADDR setup to RCLKS $\uparrow$ | 1.0 |  | ns |  |
| RDCH | RDB hold from RCLKS $\uparrow$ | 0.5 |  | ns |  |
| RDCS | RDB setup to RCLKS $\uparrow$ | 1.0 |  | ns |  |
| RPCA | New RPE access from RCLKS $\uparrow$ | 4.0 |  | ns |  |
| RPCH | Old RPE valid from RCLKS $\uparrow$ |  | 1.0 | ns |  |

## Asynchronous RAM Write


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol t $\mathbf{x x x}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| AWRH | WADDR hold from WB $\uparrow$ | 1.0 |  | ns |  |
| AWRS | WADDR setup to WB $\downarrow$ | 0.5 |  | ns |  |
| DWRH | DI hold from WB $\uparrow$ | 1.5 |  | ns |  |
| DWRS | DI setup to WB $\uparrow$ | 0.5 |  | ns | PARGEN is inactive |
| DWRS | DI setup to WB $\uparrow$ | 2.5 |  | ns | PARGEN is active |
| WPDA | WPE access from DI | 3.0 |  | ns | WPE is invalid while |
| WPDH | WPE hold from DI |  | 1.0 | ns | PARGEN is active |
| WRCYC | Cycle time | 7.5 |  | ns |  |
| WRMH | WB high phase | 3.0 |  | ns | Inactive |
| WRML | WB low phase | 3.0 |  | ns | Active |

## Asynchronous RAM Read, Address Controlled, RDB=0


$\mathbf{T}_{\mathbf{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| ${\text { Symbol } \mathbf{t}_{\mathbf{x x}}}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| ACYC | Read cycle time | 7.5 |  | ns |  |
| OAA | New DO access from RADDR stable | 7.5 |  | ns |  |
| OAH | Old DO hold from RADDR stable |  | 3.0 | ns |  |
| RPAA | New RPE access from RADDR stable | 10.0 |  | ns |  |
| RPAH | Old RPE hold from RADDR stable |  | 3.0 | ns |  |

Asynchronous RAM Read, RDB Controlled

$\mathrm{T}_{\mathbf{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\text {DDL }}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol $\mathbf{t x x x}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| ORDA | New DO access from RB $\downarrow$ | 7.5 |  | ns |  |
| ORDH | Old DO valid from RB $\downarrow$ |  | 3.0 | ns |  |
| RDCYC | Read cycle time | 7.5 |  | ns |  |
| RDMH | RB high phase | 3.0 |  | ns | Inactive setup to new cycle |
| RDML | RB low phase | 3.0 |  | ns | Active |
| RPRDA | New RPE access from RB $\downarrow$ | 9.5 |  | ns |  |
| RPRDH | Old RPE valid from RB $\downarrow$ |  | 3.0 | ns |  |

## Synchronous RAM Write


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol t $\mathbf{x x x}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| CCYC | Cycle time | 7.5 |  | ns |  |
| CMH | Clock high phase | 3.0 |  | ns |  |
| CML | Clock low phase | 3.0 |  | ns |  |
| DCH | DI hold from WCLKS $\uparrow$ | 0.5 |  | ns |  |
| DCS | DI setup to WCLKS $\uparrow$ | 1.0 |  | ns |  |
| WACH | WADDR hold from WCLKS $\uparrow$ | 0.5 |  | ns |  |
| WDCS | WADDR setup to WCLKS $\uparrow$ | 1.0 |  | ns |  |
| WPCA | New WPE access from WCLKS $\uparrow$ | 3.0 |  | ns | WPE is invalid while |
| WPCH | Old WPE valid from WCLKS $\uparrow$ | 0.5 | ns | PARGEN is active |  |
| WRCH, <br> WBCH | WRB \& WBLKB hold from WCLKS $\uparrow$ | 0.5 |  | ns |  |
| WRCS, <br> WBCS | WRB \& WBLKB setup to WCLKS $\uparrow$ | 1.0 |  | ns |  |

Note: $\quad$ On simultaneous read and write accesses to the same location DI is output to DO.

## Asynchronous FIFO Full and Empty Transitions

The asynchronous FIFO accepts writes and reads while not full or not empty. When the FIFO is full, all writes are inhibited. Conversely, when the FIFO is empty, all reads are inhibited. A problem is created if the FIFO is written during the transition out of full to not full or read during the transition out of empty to not empty. The exact time at which the write (read) operation changes from inhibited to accepted after the read (write) signal which causes the transition from full (empty) to not full (empty) is indeterminate. This indeterminate period starts 1 ns after the RB (WB) transition which deactivates full (not empty). For slow cycles, the indeterminate period ends 3ns after the RB (WB) transition. For fast cycles, this period ends either 3 ns or (7.5ns - $\mathrm{t}_{\mathrm{RDL}}\left(\mathrm{t}_{\mathrm{WRL}}\right)$ ) after the RB (WB) transition, whichever is later.

The timing diagram for write is shown in Figure 19 on page 35. The timing diagram for read is shown in Figure 20
on page 35. For basic RAM configurations, see Table 3 on page 12. For memory block interface signals, see Table 4 on page 28, and for memory block FIFO signals, see Table 5.

Enclosed Timing Diagrams-FIFO Mode:

- Asynchronous FIFO Read
- Asynchronous FIFO Write
- Synchronous FIFO Read, Access Timed Output Strobe (Synchronous Transparent)
- Synchronous FIFO Read, Pipeline Mode Outputs (Synchronous Pipelined)
- Synchronous FIFO Write
- FIFO Reset

Table 5 - Memory Block FIFO Interface Signals

| FIFO Signal | Bits | In/Out | Description |
| :--- | :--- | :--- | :--- |
| WCLKS | 1 | IN | Write clock used to synchronize write side |
| RCLKS | 1 | IN | Read clock used to synchronize read side |
| LEVEL <0:7> | 8 | IN | Direct configuration implements static flag logic |
| RBLKB | 1 | IN | Active low read block select |
| RDB | 1 | IN | Active low read pulse |
| RESET | 1 | IN | Active low reset for FIFO pointers |
| WBLKB | 1 | IN | Active low write block select |
| DI<0:8> | 2 | IN | Input data bits <0:8>, <8> can be used for parity in. |
| WRB | 2 | OUT | EQTH is true when the FIFO holds (LEVEL) words. GEQTH is true when the <br> FIFO holds (LEVEL) words or more |
| FULL, EMPTY | 9 | OUT | Output data bits <0:8>, <8> can be used for parity out. |
| EQTH, GEQTH | 1 | OUT | Read parity error |
| DO<0:8> | 1 | OUT | Write parity error |
| RPE | 3 | IN | Configures DEPTH of the FIFO to 2 (LGDEP+1) |
| WPE | 1 | IN | Selects odd parity generation/detect when high, even when low |
| LGDEP <0:2> |  |  |  |
| PARODD |  |  |  |



Figure 19 - Write Timing Diagram


Figure 20 • Read Timing Diagram

## Asynchronous FIFO Read


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol t $\mathbf{x x x}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| ERDH, <br> FRDH, <br> THRDH | Old EMPTY, FULL, EQTH, \& GETH valid <br> hold time from RB $\uparrow$ |  | 0.5 | ns | Empty/full/thresh are invalid <br> from the end of hold until the <br> new access is complete |
| ERDA | New EMPTY access from RB $\uparrow$ | $3.0^{1}$ |  | ns |  |
| FRDA | FULL $\downarrow$ access from RB $\uparrow$ | $3.0^{1}$ |  | ns |  |
| ORDA | New DO access from RB $\downarrow$ | 7.5 |  | ns |  |
| ORDH | Old DO valid from RB $\downarrow$ |  | 3.0 | ns |  |
| RDCYC | Read cycle time | 7.5 |  | ns |  |
| RDWRS | WB $\uparrow$, clearing EMPTY, setup to <br> RB $\downarrow$ | $3.0^{2}$ |  | ns | Enabling the read operation |
|  | RB high phase | 3.0 |  | ns | Inhibiting the read operation |
| RDH | RB low phase | 3.0 |  | ns | Active |
| RDL | RPRactive |  |  |  |  |
| RPRDA | New RPE access from RB $\downarrow$ | 9.5 |  | ns |  |
| RPRDH | Old RPE valid from RB $\downarrow$ | 4.5 |  | ns |  |
| THRDA | EQTH or GETH access from RB $\uparrow$ |  |  |  |  |

## Notes:

1. At fast cycles, ERDA \& FRDA $=M A X((7.5 n s-R D L), 3.0 n s)$
2. At fast cycles, RDWRS (for enabling read) $=$ MAX ((7.5ns - WRL), 3.0ns)

## Asynchronous FIFO Write


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol t $\mathbf{x x x}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| DWRH | DI hold from WB $\uparrow$ | 1.5 |  | ns |  |
| DWRS | DI setup to WB $\uparrow$ | 0.5 |  | ns | PARGEN is inactive |
| DWRS | DI setup to WB $\uparrow$ | 2.5 |  | ns | PARGEN is active |
| EWRH, <br> FWRH, <br> THWRH | Old EMPTY, FULL, EQTH, \& GETH valid <br> hold time after WB $\uparrow$ |  | 0.5 | ns | Empty/full/thresh are invalid <br> from the end of hold until the <br> new access is complete |
| EWRA | EMPTY $\downarrow$ access from WB $\uparrow$ | $3.0^{\uparrow}$ |  | ns |  |
| FWRA | New FULL access from WB $\uparrow$ | $3.0^{\uparrow}$ |  | ns |  |
| THWRA | EQTH or GETH access from WB $\uparrow$ | 4.5 |  | ns |  |
| WPDA | WPE access from DI | 3.0 |  | ns | WPE is invalid while |
| WPDH | WPE hold from DI |  | 1.0 | ns | PARGEN is active |

## Notes:

1. Atfast cycles, $E W R A, F W R A=M A X((7.5 n s-W R L), 3.0 n s)$
2. Atfast cycles, WRRDS (for enabling write) $=$ MAX ((7.5ns - RDL), 3.0ns)

## Synchronous FIFO Read, Access Timed Output Strobe (Synchronous Transparent)


$\mathrm{T}_{\mathbf{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C}$; $\mathrm{V}_{\text {DDL }}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol $\mathbf{t}_{\mathbf{x x}}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| CCYC | Cycle time | 7.5 |  | ns |  |
| CMH | Clock high phase | 3.0 |  | ns |  |
| CML | Clock low phase | 3.0 |  | ns |  |
| ECBA | New EMPTY access from RCLKS $\downarrow$ | $3.0^{\top}$ |  | ns |  |
| FCBA | FULL $\downarrow$ access from RCLKS $\downarrow$ | $3.0^{\top}$ |  | ns |  |
| ECBH, <br> FCBH, <br> THCBH | Old EMPTY, FULL, EQTH, \& GETH valid <br> hold time from RCLKS $\downarrow$ |  | 1.0 | ns | Empty/full/thresh are invalid <br> from the end of hold until the <br> new access is complete |
| OCA | New DO access from RCLKS $\uparrow$ | 7.5 |  | ns |  |
| OCH | Old DO valid from RCLKS $\uparrow$ |  | 3.0 | ns |  |
| RDCH | RDB hold from RCLKS $\uparrow$ | 0.5 |  | ns |  |
| RDCS | RDB setup to RCLKS $\uparrow$ | 1.0 |  | ns |  |
| RPCA | New RPE access from RCLKS $\uparrow$ | 9.5 |  | ns |  |
| RPCH | Old RPE valid from RCLKS $\uparrow$ |  | 3.0 | ns |  |
| HCBA | EQTH or GETH access from RCLKS $\downarrow$ | 4.5 |  | ns |  |

## Note:

1. At fast cycles, ECBA \& FCBA $=\operatorname{MAX}((7.5 n s-C M H)$, 3.0ns $)$

## Synchronous FIFO Read, Pipeline Mode Outputs (Synchronous Pipelined)


$\mathrm{T}_{\mathbf{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol t $\mathbf{x x x}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :--- |
| CCYC | Cycle time | 7.5 |  | ns |  |
| CMH | Clock high phase | 3.0 |  | ns |  |
| CML | Clock low phase | 3.0 |  | ns |  |
| ECBA | New EMPTY access from RCLKS $\downarrow$ | $3.0^{1}$ |  | ns |  |
| FCBA | FULL $\downarrow$ access from RCLKS $\downarrow$ | $3.0^{\uparrow}$ |  | ns |  |
| ECBH, <br> FCBH, <br> THCBH | Old EMPTY, FULL, EQTH, \& GETH valid <br> hold time from RCLKS $\downarrow$ |  | 1.0 | ns | Empty/full/thresh are invalid <br> from the end of hold until the <br> new access is complete |
| OCA | New DO access from RCLKS $\uparrow$ | 2.0 |  | ns |  |
| OCH | Old DO valid from RCLKS $\uparrow$ |  | 0.75 | ns |  |
| RDCH | RDB hold from RCLKS $\uparrow$ | 1.0 |  | ns |  |
| RDCS | RDB setup to RCLKS $\uparrow$ | 4.0 |  | ns |  |
| RPCA | New RPE access from RCLKS $\uparrow$ |  | 1.0 | ns |  |
| RPCH | Old RPE valid from RCLKS $\uparrow$ | 4.5 |  | ns |  |
| HCBA | EQTH or GETH access from RCLKS $\downarrow$ |  |  |  |  |

Note:

1. At fast cycles, $E C B A \& F C B A=M A X((7.5 n s-C M S)$, 3.0ns $)$

## Synchronous FIFO Write


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol txxx | Description | Min. | Max. | Units | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: |
| CCYC | Cycle time | 7.5 |  | ns |  |
| CMH | Clock high phase | 3.0 |  | ns |  |
| CML | Clock low phase | 3.0 |  | ns |  |
| DCH | DI hold from WCLKS $\uparrow$ | 0.5 |  | ns |  |
| DCS | DI setup to WCLKS $\uparrow$ | 1.0 |  | ns |  |
| FCBA | New FULL access from WCLKS $\downarrow$ | $3.0{ }^{1}$ |  | ns |  |
| ECBA | EMPTY $\downarrow$ access from WCLKS $\downarrow$ | $3.0{ }^{1}$ |  | ns |  |
| $\begin{aligned} & \text { ECBH, } \\ & \text { FCBH, } \\ & \text { HCBH } \end{aligned}$ | Old EMPTY, FULL, EQTH, \& GETH valid hold time from WCLKS $\downarrow$ |  | 1.0 | ns | Empty/full/thresh are invalid from the end of hold until the new access is complete |
| HCBA | EQTH or GETH access from WCLKS $\downarrow$ | 4.5 |  | ns |  |
| WPCA | New WPE access from WCLKS $\uparrow$ | 3.0 |  | ns | WPE is invalid while |
| WPCH | Old WPE valid from WCLKS $\uparrow$ |  | 0.5 | ns | PARGEN is active |
| WRCH, WBCH | WRB \& WBLKB hold from WCLKS $\uparrow$ | 0.5 |  | ns |  |
| WRCS, WBCS | WRB \& WBLKB setup to WCLKS $\uparrow$ | 1.0 |  | ns |  |

## Note:

1. At fast cycles, $E C B A \& F C B A=M A X((7.5 n s-C M H)$, 3.0ns $)$

## FIFO Reset


$\mathrm{T}_{\mathrm{J}}=0^{\circ} \mathrm{C}$ to $110^{\circ} \mathrm{C} ; \mathrm{V}_{\mathrm{DDL}}=2.3 \mathrm{~V}$ to 2.7 V

| Symbol $\mathrm{t}_{\text {xxx }}$ | Description | Min. | Max. | Units | Notes |
| :--- | :--- | :---: | :---: | :---: | :---: |
| CBRSH | WCLKS or RCLKS $\uparrow$ hold from RESETB $\uparrow$ | 1.5 |  | ns | Synchronous mode only |
| CBRSS | WCLKS or RCLKS $\downarrow$ setup to RESETB $\uparrow$ | 1.5 |  | ns | Synchronous mode only |
| ERSA | New EMPTY $\uparrow$ access from RESETB $\downarrow$ | 3.0 |  | ns |  |
| FRSA | FULL $\downarrow$ access from RESETB $\downarrow$ | 3.0 |  | ns |  |
| RSL | RESETB low phase | 7.5 |  | ns |  |
| THRSA | EQTH or GETH access from RESETB $\downarrow$ | 4.5 |  | ns |  |
| WBRSH | WB $\downarrow$ hold from RESETB $\uparrow$ | 1.5 |  | ns | Asynchronous mode only |
| WBRSS | WB $\uparrow$ setup to RESETB $\uparrow$ | 1.5 |  | ns | Asynchronous mode only |

## Pin Description

## I/O User Input/Output

The I/O pin functions as an input, output, three-state, or bidirectional buffer. Input and output signal levels are compatible with standard LVTTL and LVCMOS specifications. Unused I/0 pins are configured as inputs with pull-up resistors.

## N/C <br> No Connect

To maintain compatibility with future Actel ProASIC products it is recommended that this pin not be connected to the circuitry on the board.

## GL Global Input Pin

Low skew input pin for clock or other global signals. Input only. This pin can be configured with a pull-up resistor.

GND

## Ground

Common ground supply voltage.
$\mathbf{V}_{\text {DDL }}$
Logic Array Power Supply Pin 2.5 V supply voltage.
$\mathbf{V}_{\text {DDP }}$
I/O Pad Power Supply Pin
2.5 V or 3.3 V supply voltage.

## $\mathbf{V}_{\mathbf{P P}}$

Programming Supply Pin
This pin must be connected to $\mathrm{V}_{\mathrm{DDP}}$ during normal operation, or it can remain at 16.5 V in an ISP application. This pin must not float.
$\mathbf{V}_{\text {PN }} \quad$ Programming Supply Pin
This pin must be connected to GND during normal operation, or it can remain at -12 V in an ISP application. This pin must not float.

## TMS Test Mode Select

The TMS pin controls the use of Boundary Scan circuitry.

## TCK <br> Test Clock

Clock input pin for Boundary Scan.

## TDI

Test Data In
Serial input for Boundary Scan.

## TDO Test Data Out

Serial output for Boundary Scan.

## TRST Test Reset Input

Asynchronous, active low input pin for resetting Boundary Scan circuitry.

## RCK Running Clock

A free running clock is needed during programming if the programmer cannot guarantee that TCK will be uninterrupted.

## Package Pin Assignments

208-Pin PQFP


## 208-Pin PQFP

| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K050 <br> Function | A500K130 Function | A500K180 <br> Function | $\begin{gathered} \hline \text { A500K270 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: |
| 1 | GND | GND | GND | GND |
| 2 | I/O | I/O | I/O | I/O |
| 3 | I/O | I/O | I/O | I/O |
| 4 | I/O | I/O | I/O | I/O |
| 5 | I/O | I/O | I/O | I/O |
| 6 | I/O | I/O | I/O | I/O |
| 7 | I/O | I/O | I/O | I/O |
| 8 | I/O | I/O | I/O | I/O |
| 9 | I/O | I/O | I/O | I/O |
| 10 | I/O | I/O | I/O | I/O |
| 11 | I/O | I/O | I/O | I/O |
| 12 | I/O | I/O | I/O | I/O |
| 13 | I/O | I/O | I/O | I/O |
| 14 | I/O | I/O | I/O | I/O |
| 15 | I/O | I/O | I/O | I/O |
| 16 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 17 | GND | GND | GND | GND |
| 18 | I/O | I/O | I/O | I/O |
| 19 | I/O | I/O | I/O | I/O |
| 20 | I/O | I/O | I/O | I/O |
| 21 | I/O | I/O | I/O | I/O |
| 22 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 23 | I/O | I/O | I/O | I/O |
| 24 | I/O | I/O | I/O | I/O |
| 25 | GL | GL | GL | GL |
| 26 | GL | GL | GL | GL |
| 27 | I/O | I/O | I/O | I/O |
| 28 | I/O | I/O | I/O | I/O |
| 29 | GND | GND | GND | GND |
| 30 | I/O | I/O | I/O | I/O |
| 31 | I/O | I/O | I/O | I/O |
| 32 | I/O | I/O | I/O | I/O |
| 33 | I/O | I/O | I/O | I/O |
| 34 | I/O | I/O | I/O | I/O |
| 35 | I/O | I/O | I/O | I/O |
| 36 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 37 | I/O | I/O | I/O | I/O |
| 38 | I/O | I/O | I/O | I/O |
| 39 | I/O | I/O | I/O | I/O |
| 40 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 41 | GND | GND | GND | GND |
| 42 | I/O | I/O | I/O | I/O |
| 43 | I/O | I/O | I/O | I/O |
| 44 | I/O | I/O | I/O | I/O |
| 45 | I/O | I/O | I/O | I/O |
| 46 | I/O | I/O | I/O | I/O |
| 47 | I/O | I/O | I/O | I/O |
| 48 | I/O | I/O | I/O | I/O |
| 49 | I/O | I/O | I/O | I/O |
| 50 | I/O | I/O | I/O | I/O |
| 51 | I/O | I/O | I/O | I/O |
| 52 | GND | GND | GND | GND |


| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | $\begin{gathered} \hline \text { A500K050 } \\ \text { Function } \end{gathered}$ | $\begin{aligned} & \hline \text { A500K130 } \\ & \text { Function } \end{aligned}$ | $\begin{gathered} \hline \text { A500K180 } \\ \text { Function } \end{gathered}$ | $\begin{gathered} \hline \text { A500K270 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: |
| 53 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 54 | I/O | I/O | I/O | I/O |
| 55 | I/O | I/O | I/O | I/O |
| 56 | I/O | 1/O | I/O | I/O |
| 57 | I/O | 1/O | I/O | 1/O |
| 58 | I/O | I/O | I/O | 1/O |
| 59 | I/O | I/O | I/O | I/O |
| 60 | I/O | I/O | I/O | I/O |
| 61 | I/O | I/O | I/O | I/O |
| 62 | I/O | I/O | I/O | I/O |
| 63 | I/O | I/O | I/O | I/O |
| 64 | I/O | I/O | 1/O | I/O |
| 65 | GND | GND | GND | GND |
| 66 | I/O | I/O | I/O | I/O |
| 67 | I/O | I/O | I/O | I/O |
| 68 | I/O | I/O | I/O | I/O |
| 69 | I/O | I/O | I/O | I/O |
| 70 | I/O | I/O | I/O | I/O |
| 71 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 72 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 73 | I/O | I/O | I/O | I/O |
| 74 | I/O | I/O | I/O | I/O |
| 75 | I/O | I/O | I/O | I/O |
| 76 | I/O | I/O | I/O | I/O |
| 77 | I/O | I/O | I/O | I/O |
| 78 | I/O | I/O | I/O | I/O |
| 79 | 1/0 | I/O | I/O | I/O |
| 80 | I/O | I/O | I/O | I/O |
| 81 | GND | GND | GND | GND |
| 82 | I/O | I/O | I/O | I/O |
| 83 | 1/O | I/O | I/O | 1/0 |
| 84 | 1/0 | 1/0 | I/O | 1/0 |
| 85 | I/O | I/O | I/O | 1/0 |
| 86 | I/O | I/O | I/O | 1/0 |
| 87 | I/O | I/O | I/O | I/O |
| 88 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 89 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| 90 | I/O | I/O | I/O | I/O |
| 91 | I/O | 1/0 | 1/O | 1/0 |
| 92 | I/O | 1/0 | 1/O | I/O |
| 93 | I/O | I/O | 1/O | 1/O |
| 94 | I/O | I/O | I/O | I/O |
| 95 | I/O | 1/0 | 1/O | 1/O |
| 96 | I/O | I/O | I/O | I/O |
| 97 | GND | GND | GND | GND |
| 98 | I/O | I/O | I/O | I/O |
| 99 | I/O | 1/O | 1/O | 1/0 |
| 100 | I/O | I/O | I/O | I/O |
| 101 | TCK | TCK | TCK | TCKO |
| 102 | TDI | TDI | TDI | TDI |
| 103 | TMS | TMS | TMS | TMS |
| 104 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |

208-Pin PQFP (Continued)

| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K050 Function | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: | :---: |
| 105 | GND | GND | GND | GND |
| 106 | $V_{\text {PP }}$ | $V_{\text {PP }}$ | $V_{\text {PP }}$ | $V_{\text {PP }}$ |
| 107 | $\mathrm{V}_{\mathrm{PN}}$ | $\mathrm{V}_{\mathrm{PN}}$ | $\mathrm{V}_{\mathrm{PN}}$ | $\mathrm{V}_{\mathrm{PN}}$ |
| 108 | TDO | TDO | TDO | TDO |
| 109 | TRST | TRST | TRST | TRST |
| 110 | RCK | RCK | RCK | RCK |
| 111 | I/O | I/O | I/O | I/O |
| 112 | I/O | I/O | I/O | I/O |
| 113 | I/O | I/O | I/O | I/O |
| 114 | I/O | I/O | I/O | I/O |
| 115 | I/O | 1/O | I/O | I/O |
| 116 | I/O | I/O | I/O | I/O |
| 117 | I/O | I/O | I/O | I/O |
| 118 | I/O | I/O | I/O | I/O |
| 119 | I/O | I/O | I/O | I/O |
| 120 | I/O | 1/O | I/O | I/O |
| 121 | I/O | I/O | I/O | I/O |
| 122 | GND | GND | GND | GND |
| 123 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| 124 | I/O | I/O | I/O | I/O |
| 125 | I/O | I/O | I/O | I/O |
| 126 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 127 | I/O | I/O | I/O | I/O |
| 128 | I/O | I/O | I/O | I/O |
| 129 | I/O | I/O | I/O | I/O |
| 130 | GND | GND | GND | GND |
| 131 | I/O | I/O | I/O | I/O |
| 132 | I/O | I/O | I/O | I/O |
| 133 | GL | GL | GL | GL |
| 134 | GL | GL | GL | GL |
| 135 | I/O | I/O | I/O | I/O |
| 136 | I/O | I/O | I/O | I/O |
| 137 | I/O | I/O | I/O | I/O |
| 138 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 139 | I/O | I/O | I/O | I/O |
| 140 | I/O | I/O | I/O | I/O |
| 141 | GND | GND | GND | GND |
| 142 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 143 | I/O | I/O | I/O | I/O |
| 144 | I/O | 1/O | I/O | 1/O |
| 145 | I/O | 1/O | 1/O | I/O |
| 146 | I/O | I/O | I/O | I/O |
| 147 | I/O | I/O | I/O | I/O |
| 148 | I/O | I/O | I/O | 1/O |
| 149 | I/O | I/O | I/O | I/O |
| 150 | I/O | I/O | I/O | I/O |
| 151 | I/O | I/O | I/O | I/O |
| 152 | I/O | I/O | I/O | I/O |
| 153 | I/O | I/O | I/O | I/O |
| 154 | I/O | I/O | I/O | I/O |
| 155 | I/O | I/O | I/O | I/O |
| 156 | GND | GND | GND | GND |


| Pin Number | A500K050 Function | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: | :---: |
| 157 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 158 | I/O | I/O | I/O | I/O |
| 159 | I/O | I/O | I/O | I/O |
| 160 | I/O | I/O | I/O | I/O |
| 161 | I/O | I/O | I/O | I/O |
| 162 | GND | GND | GND | GND |
| 163 | I/O | I/O | I/O | I/O |
| 164 | 1/0 | I/O | I/O | I/O |
| 165 | I/O | I/O | I/O | I/O |
| 166 | I/O | I/O | I/O | I/O |
| 167 | I/O | I/O | I/O | I/O |
| 168 | 1/0 | I/O | I/O | 1/0 |
| 169 | I/O | I/O | I/O | I/O |
| 170 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 171 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 172 | I/O | I/O | I/O | I/O |
| 173 | I/O | I/O | I/O | I/O |
| 174 | 1/0 | I/O | I/O | I/O |
| 175 | 1/0 | I/O | 1/0 | 1/0 |
| 176 | 1/0 | 1/0 | I/O | 1/0 |
| 177 | I/O | I/O | I/O | I/O |
| 178 | GND | GND | GND | GND |
| 179 | I/O | I/O | I/O | I/O |
| 180 | I/O | I/O | I/O | I/O |
| 181 | I/O | I/O | I/O | I/O |
| 182 | I/O | I/O | I/O | I/O |
| 183 | I/O | I/O | 1/O | 1/0 |
| 184 | I/O | I/O | I/O | I/O |
| 185 | I/O | I/O | I/O | I/O |
| 186 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| 187 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| 188 | I/O | I/O | I/O | I/O |
| 189 | I/O | 1/0 | 1/O | I/O |
| 190 | I/O | I/O | 1/O | I/O |
| 191 | I/O | I/O | I/O | I/O |
| 192 | 1/0 | 1/0 | 1/0 | 1/0 |
| 193 | I/O | 1/O | I/O | I/O |
| 194 | I/O | I/O | I/O | I/O |
| 195 | GND | GND | GND | GND |
| 196 | I/O | I/O | I/O | I/O |
| 197 | I/O | 1/0 | I/O | I/O |
| 198 | 1/O | 1/O | I/O | I/O |
| 199 | I/O | I/O | 1/O | I/O |
| 200 | I/O | 1/0 | I/O | I/O |
| 201 | I/O | 1/O | I/O | I/O |
| 202 | I/O | I/O | I/O | I/O |
| 203 | I/O | I/O | I/O | I/O |
| 204 | I/O | I/O | 1/O | I/O |
| 205 | I/O | 1/O | 1/O | I/O |
| 206 | I/O | I/O | 1/O | 1/O |
| 207 | I/O | I/O | I/O | I/O |
| 208 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |

## Package Pin Assignments (Continued)

## 272-Pin PBGA (Bottom View)



## 272-Pin PBGA

| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K050 Function | A500K130 Function |
| :---: | :---: | :---: |
| A1 | I/O | I/O |
| A2 | 1/0 | 1/0 |
| A3 | I/O | I/O |
| A4 | 1/0 | 1/0 |
| A5 | I/O | I/O |
| A6 | I/O | 1/0 |
| A7 | I/O | I/O |
| A8 | 1/0 | 1/0 |
| A9 | I/O | 1/0 |
| A10 | I/O | I/O |
| A11 | 1/0 | I/O |
| A12 | 1/0 | 1/0 |
| A13 | 1/0 | 1/0 |
| A14 | I/O | I/O |
| A15 | 1/0 | I/O |
| A16 | I/O | I/O |
| A17 | 1/0 | 1/0 |
| A18 | I/O | I/O |
| A19 | 1/0 | I/O |
| A20 | I/O | I/O |
| B1 | 1/0 | 1/0 |
| B2 | 1/0 | 1/0 |
| B3 | 1/0 | 1/0 |
| B4 | 1/0 | I/O |
| B5 | 1/0 | 1/0 |
| B6 | 1/0 | I/O |
| B7 | 1/0 | I/O |
| B8 | 1/0 | I/O |
| B9 | 1/0 | 1/0 |
| B10 | 1/0 | I/O |
| B11 | I/O | I/O |
| B12 | 1/0 | 1/0 |
| B13 | 1/0 | I/O |
| B14 | 1/0 | I/O |
| B15 | I/O | I/O |
| B16 | 1/0 | 1/0 |
| B17 | I/O | I/O |
| B18 | 1/0 | I/O |
| B19 | 1/0 | I/O |
| B20 | I/O | I/O |
| C1 | I/O | I/O |
| C2 | 1/0 | I/O |
| C3 | 1/0 | 1/0 |
| C4 | I/O | I/O |
| C5 | 1/0 | I/O |
| C6 | I/O | I/O |


| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K050 Function | A500K130 |
| :---: | :---: | :---: |
| C7 | I/O | I/O |
| C8 | 1/0 | I/O |
| C9 | I/O | I/O |
| C10 | 1/0 | 1/0 |
| C11 | 1/0 | 1/0 |
| C12 | 1/0 | 1/0 |
| C13 | 1/0 | 1/0 |
| C14 | I/O | 1/0 |
| C15 | I/O | I/O |
| C16 | 1/0 | 1/0 |
| C17 | 1/0 | 1/0 |
| C18 | 1/0 | 1/0 |
| C19 | 1/0 | 1/0 |
| C20 | 1/0 | 1/0 |
| D1 | 1/0 | 1/0 |
| D2 | I/O | I/O |
| D3 | I/O | I/O |
| D4 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| D5 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| D6 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| D7 | I/O | I/O |
| D8 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| D9 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| D10 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| D11 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| D12 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| D13 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| D14 | I/O | I/O |
| D15 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| D16 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| D17 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| D18 | 1/0 | I/O |
| D19 | 1/0 | I/O |
| D20 | 1/0 | 1/0 |
| E1 | 1/0 | I/O |
| E2 | 1/0 | 1/0 |
| E3 | I/O | I/O |
| E4 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| E17 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| E18 | I/O | I/O |
| E19 | 1/0 | 1/0 |
| E20 | 1/0 | 1/0 |
| F1 | 1/0 | 1/0 |
| F2 | 1/0 | 1/0 |
| F3 | I/O | I/O |
| F4 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |


| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | $\begin{gathered} \text { A500K050 } \\ \text { Function } \end{gathered}$ | $\begin{gathered} \text { A500K130 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: | :---: |
| F17 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| F18 | I/O | I/O |
| F19 | I/O | I/O |
| F20 | I/O | I/O |
| G1 | 1/0 | I/O |
| G2 | I/O | 1/0 |
| G3 | 1/0 | 1/0 |
| G4 | I/O | 1/0 |
| G17 | I/O | 1/0 |
| G18 | 1/0 | I/O |
| G19 | I/O | I/O |
| G20 | 1/0 | 1/0 |
| H1 | 1/0 | I/O |
| H2 | 1/0 | I/O |
| H3 | I/O | I/O |
| H4 | I/O | I/O |
| H17 | I/O | I/O |
| H18 | I/O | 1/0 |
| H19 | I/O | I/O |
| H2O | GL | GL |
| J1 | I/O | I/O |
| J2 | GL | GL |
| J3 | GL | GL |
| J4 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| J9 | GND | GND |
| J10 | GND | GND |
| J11 | GND | GND |
| J12 | GND | GND |
| J17 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| J18 | GL | GL |
| J19 | I/O | I/O |
| J20 | I/O | 1/0 |
| K1 | 1/0 | 1/0 |
| K2 | 1/0 | I/O |
| K3 | I/O | 1/O |
| K4 | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| K9 | GND | GND |
| K10 | GND | GND |
| K11 | GND | GND |
| K12 | GND | GND |
| K17 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| K18 | I/O | I/O |
| K19 | 1/0 | 1/0 |
| K20 | 1/0 | 1/0 |
| L1 | 1/0 | 1/0 |
| L2 | 1/0 | I/O |

## 272-Pin PBGA (Continued)

| Pin Number | A500K050 Function | A500K130 Function |
| :---: | :---: | :---: |
| L3 | I/O | I/O |
| L4 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| L9 | GND | GND |
| L10 | GND | GND |
| L11 | GND | GND |
| L12 | GND | GND |
| L17 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| L18 | I/O | I/O |
| L19 | I/O | I/O |
| L20 | I/O | I/O |
| M1 | I/O | I/O |
| M2 | 1/O | I/O |
| M3 | I/O | I/O |
| M4 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| M9 | GND | GND |
| M10 | GND | GND |
| M11 | GND | GND |
| M12 | GND | GND |
| M17 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| M18 | I/O | I/O |
| M19 | I/O | I/O |
| M20 | I/O | I/O |
| N1 | I/O | I/O |
| N2 | I/O | I/O |
| N3 | I/O | I/O |
| N4 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| N17 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| N18 | I/O | I/O |
| N19 | I/O | I/O |
| N20 | I/O | I/O |
| P1 | I/O | I/O |
| P2 | I/O | I/O |
| P3 | I/O | I/O |
| P4 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| P17 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| P18 | I/O | I/O |
| P19 | I/O | I/O |
| P20 | I/O | I/O |
| R1 | I/O | I/O |
| R2 | I/O | I/O |
| R3 | I/O | I/O |
| R4 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| R17 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| R18 | I/O | I/O |
| R19 | I/O | I/O |
| R20 | 1/O | 1/O |


| Pin Number | A500K050 Function | A500K130 Function |
| :---: | :---: | :---: |
| T1 | I/O | I/O |
| T2 | I/O | I/O |
| T3 | I/O | I/O |
| T4 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| T17 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| T18 | I/O | I/O |
| T19 | I/O | I/O |
| T20 | I/O | I/O |
| U1 | I/O | I/O |
| U2 | I/O | I/O |
| U3 | I/O | I/O |
| U4 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| U5 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| U6 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| U7 | I/O | I/O |
| U8 | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| U9 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| U10 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| U11 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| U12 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| U13 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| U14 | I/O | I/O |
| U15 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| U16 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| U17 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| U18 | RCK | RCK |
| U19 | I/O | I/O |
| U20 | I/O | I/O |
| V1 | I/O | I/O |
| V2 | I/O | I/O |
| V3 | I/O | I/O |
| V4 | I/O | I/O |
| V5 | I/O | I/O |
| V6 | I/O | I/O |
| V7 | I/O | I/O |
| V8 | I/O | I/O |
| V9 | I/O | I/O |
| V10 | I/O | I/O |
| V11 | I/O | I/O |
| V12 | I/O | I/O |
| V13 | I/O | I/O |
| V14 | I/O | I/O |
| V15 | I/O | I/O |
| V16 | I/O | I/O |
| V17 | TMS | TMS |
| V18 | TDO | TDO |


| Pin Number | $\begin{aligned} & \text { A500K050 } \\ & \text { Function } \end{aligned}$ | $\begin{gathered} \text { A500K130 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: | :---: |
| V19 | I/O | I/O |
| V20 | I/O | I/O |
| W1 | I/O | I/O |
| W2 | I/O | I/O |
| W3 | I/O | I/O |
| W4 | I/O | I/O |
| W5 | I/O | I/O |
| W6 | I/O | I/O |
| W7 | I/O | I/O |
| W8 | I/O | I/O |
| W9 | I/O | I/O |
| W10 | I/O | I/O |
| W11 | I/O | I/O |
| W12 | I/O | I/O |
| W13 | I/O | I/O |
| W14 | I/O | I/O |
| W15 | I/O | I/O |
| W16 | I/O | I/O |
| W17 | TCK | TCK |
| W18 | VPP | VPP |
| W19 | TRST | TRST |
| W20 | I/O | I/O |
| Y1 | I/O | I/O |
| Y2 | I/O | I/O |
| Y3 | I/O | I/O |
| Y4 | I/O | I/O |
| Y5 | I/O | I/O |
| Y6 | I/O | I/O |
| Y7 | I/O | I/O |
| Y8 | I/O | I/O |
| Y9 | I/O | I/O |
| Y10 | I/O | I/O |
| Y11 | I/O | I/O |
| Y12 | I/O | I/O |
| Y13 | I/O | I/O |
| Y14 | I/O | I/O |
| Y15 | I/O | I/O |
| Y16 | I/O | I/O |
| Y17 | I/O | I/O |
| Y18 | TDI | TDI |
| Y19 | $\mathrm{V}_{\mathrm{PN}}$ | $\mathrm{V}_{\mathrm{PN}}$ |
| Y20 | I/O | I/O |

## Package Pin Assignments (Continued)

## 456-Pin PBGA (Bottom View)

$\begin{array}{lllllllllllllllllllllllll}26 & 25 & 24 & 23 & 22 & 21 & 20 & 19 & 18 & 17 & 16 & 15 & 14 & 13 & 12 & 11 & 10 & 9 & 8 & 7 & 6 & 5 & 4 & 3 & 2\end{array} 1$

A
B
C
D
E

F
G
H
J
K
L

N

## P

B
R
T

00000000000000000000000000 00000000000000000000000000 ०००००००००००००००००००००००००० 00000000000000000000000000 00000000000000000000000000 00000
00000
00000
00000
00000
○OOOO
00000
○○○○○
○○○○
00000
00000
00000
00000
00000
00000
00000
000000 00000
00000
00000
00000
○○○○○
00000
00000
○○○○
○○○○○ 00000 00000 00000 00000 00000 00000 ○○○○○○○○○○○○○○○○○○○○○○○○○○ 00000000000000000000000000 00000000000000000000000000 ०००००००००००००००००००००००००० 00000000000000000000000000

## 456.Pin PBGA

| Pin Number | $\begin{gathered} \hline \text { A500K130 } \\ \text { Function } \end{gathered}$ | A500K180 Function | $\begin{gathered} \hline \text { A500K270 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: | :---: | :---: |
| A1 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| A2 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| A3 | NC | I/O | I/O |
| A4 | 1/O | 1/O | 1/O |
| A5 | I/O | 1/O | 1/O |
| A6 | NC | I/O | 1/O |
| A7 | I/O | I/O | I/O |
| A8 | NC | I/O | I/O |
| A9 | NC | I/O | 1/O |
| A10 | I/O | 1/O | 1/O |
| A11 | NC | I/O | 1/O |
| A12 | NC | I/O | 1/0 |
| A13 | I/O | I/O | I/O |
| A14 | NC | I/O | 1/O |
| A15 | NC | 1/O | 1/O |
| A16 | I/O | I/O | I/O |
| A17 | NC | I/O | 1/O |
| A18 | NC | I/O | I/O |
| A19 | I/O | I/O | I/O |
| A20 | NC | I/O | 1/O |
| A21 | NC | I/O | I/O |
| A22 | I/O | I/O | I/O |
| A23 | NC | I/O | I/O |
| A24 | NC | I/O | I/O |
| A25 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| A26 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| AA1 | I/O | I/O | I/O |
| AA2 | 1/0 | 1/0 | 1/0 |
| AA3 | I/O | I/O | I/O |
| AA4 | I/O | I/O | I/O |
| AA5 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| AA22 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| AA23 | I/O | I/O | 1/O |
| AA24 | 1/O | 1/O | 1/0 |
| AA25 | I/O | I/O | I/O |
| AA26 | NC | I/O | 1/O |
| AB1 | NC | I/O | 1/O |
| AB2 | I/O | I/O | 1/O |
| AB3 | I/O | I/O | I/O |
| AB4 | I/O | I/O | I/O |
| AB5 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| AB6 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| AB7 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| AB8 | I/O | I/O | I/O |
| AB9 | I/O | I/O | I/O |
| AB10 | 1/O | I/O | 1/O |


| Pin Number | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| AB11 | I/O | I/O | I/O |
| AB12 | 1/O | 1/O | 1/O |
| AB13 | 1/O | I/O | 1/O |
| AB14 | I/O | I/O | I/O |
| AB15 | I/O | I/O | I/O |
| AB16 | I/O | I/O | I/O |
| AB17 | I/O | I/O | I/O |
| AB18 | 1/O | 1/O | 1/O |
| AB19 | I/O | I/O | I/O |
| AB20 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| AB21 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| AB22 | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| AB23 | I/O | I/O | I/O |
| AB24 | I/O | I/O | I/O |
| AB25 | I/O | I/O | I/O |
| AB26 | I/O | I/O | I/O |
| AC1 | I/O | I/O | I/O |
| AC2 | I/O | I/O | I/O |
| AC3 | I/O | I/O | I/O |
| AC4 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| AC5 | I/O | I/O | I/O |
| AC6 | I/O | I/O | I/O |
| AC7 | I/O | 1/O | I/O |
| AC8 | I/O | I/O | I/O |
| AC9 | I/O | I/O | I/O |
| AC10 | I/O | I/O | 1/O |
| AC11 | I/O | I/O | I/O |
| AC12 | I/O | I/O | I/O |
| AC13 | I/O | I/O | I/O |
| AC14 | I/O | I/O | I/O |
| AC15 | I/O | I/O | I/O |
| AC16 | I/O | I/O | I/O |
| AC17 | I/O | I/O | I/O |
| AC18 | 1/O | I/O | I/O |
| AC19 | I/O | I/O | I/O |
| AC20 | I/O | I/O | I/O |
| AC21 | TMS | TMS | TMS |
| AC22 | TDO | TDO | TDO |
| AC23 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| AC24 | RCK | RCK | RCK |
| AC25 | I/O | I/O | I/O |
| AC26 | NC | I/O | I/O |
| AD1 | NC | I/O | 1/O |
| AD2 | I/O | I/O | I/O |
| AD3 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| AD4 | I/O | I/O | I/O |

456-Pin PBGA (Continued)

| Pin Number | $\begin{aligned} & \hline \text { A500K130 } \\ & \text { Function } \end{aligned}$ | $\begin{gathered} \hline \text { A500K180 } \\ \text { Function } \end{gathered}$ | $\begin{aligned} & \hline \text { A500K270 } \\ & \text { Function } \end{aligned}$ | Pin Number | $\begin{aligned} & \hline \text { A500K130 } \\ & \text { Function } \end{aligned}$ | $\begin{aligned} & \hline \text { A500K180 } \\ & \text { Function } \end{aligned}$ | $\begin{aligned} & \hline \text { A500K270 } \\ & \text { Function } \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AD5 | I/O | I/O | I/O | AE25 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| AD6 | 1/0 | 1/0 | 1/0 | AE26 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| AD7 | 1/0 | 1/0 | 1/0 | AF1 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| AD8 | 1/O | I/O | 1/O | AF2 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| AD9 | 1/O | I/O | I/O | AF3 | NC | I/O | I/O |
| AD10 | 1/0 | 1/0 | 1/0 | AF4 | NC | 1/0 | 1/O |
| AD11 | I/O | I/O | I/O | AF5 | I/O | I/O | 1/O |
| AD12 | 1/0 | I/O | 1/O | AF6 | NC | 1/0 | I/O |
| AD13 | I/O | I/O | I/O | AF7 | NC | 1/0 | 1/0 |
| AD14 | I/O | 1/0 | 1/0 | AF8 | I/O | 1/O | 1/0 |
| AD15 | 1/0 | 1/0 | 1/0 | AF9 | NC | 1/0 | 1/0 |
| AD16 | 1/0 | I/O | I/O | AF10 | NC | 1/0 | 1/0 |
| AD17 | I/O | 1/0 | I/O | AF11 | I/O | I/O | 1/O |
| AD18 | 1/O | I/O | 1/0 | AF12 | NC | 1/0 | 1/0 |
| AD19 | I/O | I/O | I/O | AF13 | NC | I/O | I/O |
| AD20 | 1/O | I/O | 1/O | AF14 | I/O | 1/0 | 1/0 |
| AD21 | TCK | TCK | TCK | AF15 | NC | 1/O | 1/0 |
| AD22 | $\mathrm{V}_{\text {PP }}$ | $\mathrm{V}_{\mathrm{PP}}$ | $V_{\text {PP }}$ | AF16 | NC | 1/0 | 1/0 |
| AD23 | I/O | I/O | I/O | AF17 | I/O | 1/0 | 1/O |
| AD24 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | AF18 | NC | 1/0 | 1/0 |
| AD25 | I/O | I/O | 1/O | AF19 | NC | 1/0 | 1/0 |
| AD26 | NC | I/O | I/O | AF20 | I/O | I/O | 1/0 |
| AE1 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | AF21 | NC | 1/0 | 1/0 |
| AE2 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | AF22 | I/O | I/O | 1/O |
| AE3 | I/O | I/O | I/O | AF23 | TDI | TDI | TDI |
| AE4 | 1/0 | 1/0 | 1/0 | AF24 | NC | I/O | I/O |
| AE5 | 1/0 | 1/0 | 1/0 | AF25 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| AE6 | 1/0 | 1/0 | 1/0 | AF26 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| AE7 | 1/0 | 1/0 | 1/0 | B1 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| AE8 | 1/0 | 1/0 | 1/0 | B2 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| AE9 | 1/O | 1/0 | 1/O | B3 | I/O | I/O | I/O |
| AE10 | 1/0 | 1/0 | 1/0 | B4 | I/O | 1/0 | 1/0 |
| AE11 | I/O | I/O | I/O | B5 | I/O | I/O | I/O |
| AE12 | 1/0 | 1/0 | 1/0 | B6 | 1/0 | 1/0 | 1/0 |
| AE13 | 1/0 | 1/0 | I/O | B7 | I/O | I/O | I/O |
| AE14 | 1/0 | 1/0 | 1/0 | B8 | 1/0 | 1/0 | 1/0 |
| AE15 | 1/0 | 1/0 | 1/O | B9 | 1/0 | 1/0 | 1/0 |
| AE16 | 1/O | 1/0 | 1/O | B10 | 1/0 | 1/0 | 1/0 |
| AE17 | 1/0 | 1/0 | 1/0 | B11 | 1/0 | 1/0 | 1/0 |
| AE18 | 1/0 | 1/0 | 1/0 | B12 | 1/0 | I/O | 1/0 |
| AE19 | 1/0 | I/O | I/O | B13 | I/O | I/O | I/O |
| AE20 | 1/0 | 1/0 | 1/0 | B14 | 1/0 | 1/0 | 1/0 |
| AE21 | 1/0 | 1/0 | 1/0 | B15 | 1/0 | 1/0 | 1/0 |
| AE22 | I/O | I/O | I/O | B16 | 1/0 | I/O | 1/0 |
| AE23 | $\mathrm{V}_{\mathrm{PN}}$ | $\mathrm{V}_{\mathrm{PN}}$ | $\mathrm{V}_{\mathrm{PN}}$ | B17 | 1/0 | 1/0 | 1/0 |
| AE24 | TRST | TRST | TRST | B18 | 1/0 | 1/0 | 1/0 |

## 456-Pin PBGA (Continued)

| Pin Number | $\begin{aligned} & \hline \text { A500K130 } \\ & \text { Function } \end{aligned}$ | $\begin{aligned} & \text { A500K180 } \\ & \text { Function } \end{aligned}$ | $\begin{aligned} & \hline \text { A500K270 } \\ & \text { Function } \end{aligned}$ |
| :---: | :---: | :---: | :---: |
| B19 | I/O | I/O | I/O |
| B20 | I/O | 1/0 | I/O |
| B21 | I/O | I/O | I/O |
| B22 | I/O | I/O | I/O |
| B23 | 1/O | 1/0 | 1/O |
| B24 | I/O | I/O | I/O |
| B25 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| B26 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| C1 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| C2 | I/O | I/O | I/O |
| C3 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| C4 | I/O | I/O | I/O |
| C5 | I/O | I/O | I/O |
| C6 | I/O | I/O | 1/O |
| C7 | 1/O | 1/O | I/O |
| C8 | I/O | I/O | I/O |
| C9 | I/O | I/O | I/O |
| C10 | I/O | I/O | I/O |
| C11 | 1/O | 1/O | I/O |
| C12 | I/O | I/O | I/O |
| C13 | I/O | I/O | I/O |
| C14 | I/O | I/O | I/O |
| C15 | 1/0 | 1/0 | I/O |
| C16 | 1/O | I/O | I/O |
| C17 | I/O | I/O | I/O |
| C18 | I/O | I/O | I/O |
| C19 | 1/0 | I/O | I/O |
| C20 | 1/0 | 1/0 | 1/O |
| C21 | 1/O | I/O | I/O |
| C22 | I/O | I/O | I/O |
| C23 | I/O | I/O | I/O |
| C24 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| C25 | 1/O | I/O | I/O |
| C26 | NC | 1/0 | I/O |
| D1 | NC | I/O | I/O |
| D2 | 1/O | 1/0 | I/O |
| D3 | I/O | I/O | I/O |
| D4 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| D5 | I/O | I/O | I/O |
| D6 | I/O | I/O | I/O |
| D7 | I/O | 1/0 | 1/O |
| D8 | 1/0 | 1/0 | I/O |
| D9 | 1/O | 1/O | I/O |
| D10 | 1/0 | 1/0 | I/O |
| D11 | I/O | I/O | I/O |
| D12 | 1/O | 1/O | 1/O |


| Pin Number | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| D13 | I/O | I/O | I/O |
| D14 | 1/O | I/O | 1/O |
| D15 | I/O | I/O | 1/O |
| D16 | I/O | I/O | I/O |
| D17 | 1/O | I/O | I/O |
| D18 | I/O | I/O | I/O |
| D19 | I/O | I/O | I/O |
| D20 | I/O | I/O | I/O |
| D21 | I/O | I/O | I/O |
| D22 | I/O | I/O | I/O |
| D23 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| D24 | I/O | I/O | I/O |
| D25 | I/O | I/O | I/O |
| D26 | I/O | I/O | I/O |
| E1 | NC | I/O | I/O |
| E2 | I/O | I/O | I/O |
| E3 | I/O | I/O | 1/O |
| E4 | I/O | I/O | I/O |
| E5 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| E6 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| E7 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| E8 | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| E9 | I/O | I/O | I/O |
| E10 | I/O | I/O | I/O |
| E11 | I/O | I/O | I/O |
| E12 | 1/O | I/O | 1/O |
| E13 | I/O | I/O | I/O |
| E14 | I/O | I/O | 1/O |
| E15 | I/O | I/O | I/O |
| E16 | I/O | I/O | I/O |
| E17 | I/O | I/O | 1/O |
| E18 | I/O | I/O | I/O |
| E19 | I/O | I/O | I/O |
| E20 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| E21 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| E22 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| E23 | I/O | I/O | I/O |
| E24 | I/O | 1/O | I/O |
| E25 | I/O | I/O | I/O |
| E26 | I/O | I/O | I/O |
| F1 | I/O | I/O | 1/O |
| F2 | I/O | I/O | I/O |
| F3 | I/O | I/O | I/O |
| F4 | I/O | I/O | I/O |
| F5 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| F22 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |

456-Pin PBGA (Continued)

| Pin Number | $\begin{gathered} \hline \text { A500K130 } \\ \text { Function } \end{gathered}$ | $\begin{gathered} \hline \text { A500K180 } \\ \text { Function } \end{gathered}$ | $\begin{aligned} & \hline \text { A500K270 } \\ & \text { Function } \end{aligned}$ |
| :---: | :---: | :---: | :---: |
| F23 | I/O | I/O | I/O |
| F24 | I/O | I/O | I/O |
| F25 | I/O | 1/O | 1/O |
| F26 | NC | I/O | 1/O |
| G1 | NC | I/O | 1/O |
| G2 | I/O | I/O | I/O |
| G3 | I/O | I/O | I/O |
| G4 | I/O | I/O | 1/O |
| G5 | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| G22 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| G23 | I/O | I/O | I/O |
| G24 | I/O | I/O | 1/O |
| G25 | 1/O | I/O | 1/O |
| G26 | I/O | I/O | I/O |
| H1 | NC | I/O | 1/O |
| H2 | I/O | I/O | I/O |
| H3 | I/O | I/O | I/O |
| H4 | I/O | I/O | I/O |
| H5 | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| H22 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| H23 | I/O | I/O | I/O |
| H24 | I/O | I/O | I/O |
| H25 | I/O | I/O | I/O |
| H26 | NC | I/O | I/O |
| J1 | I/O | I/O | I/O |
| J2 | I/O | I/O | I/O |
| J3 | I/O | I/O | I/O |
| J4 | I/O | 1/O | 1/0 |
| J5 | I/O | I/O | I/O |
| J22 | I/O | I/O | 1/O |
| J23 | I/O | I/O | I/O |
| J24 | I/O | I/O | I/O |
| J25 | I/O | I/O | I/O |
| J26 | NC | I/O | 1/O |
| K1 | NC | I/O | I/O |
| K2 | I/O | I/O | 1/0 |
| K3 | I/O | I/O | I/O |
| K4 | I/O | I/O | I/O |
| K5 | I/O | I/O | I/O |
| K22 | I/O | I/O | I/O |
| K23 | I/O | I/O | I/O |
| K24 | I/O | I/O | I/O |
| K25 | I/O | I/O | I/O |
| K26 | I/O | I/O | I/O |
| L1 | NC | I/O | I/O |
| L2 | I/O | I/O | 1/O |


| Pin Number | $\begin{gathered} \text { A500K130 } \\ \text { Function } \end{gathered}$ | $\begin{gathered} \text { A500K180 } \\ \text { Function } \end{gathered}$ | $\begin{gathered} \hline \text { A500K270 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: | :---: | :---: |
| L3 | I/O | I/O | I/O |
| L4 | I/O | I/O | I/O |
| L5 | I/O | I/O | I/O |
| L11 | GND | GND | GND |
| L12 | GND | GND | GND |
| L13 | GND | GND | GND |
| L14 | GND | GND | GND |
| L15 | GND | GND | GND |
| L16 | GND | GND | GND |
| L22 | I/O | I/O | I/O |
| L23 | 1/O | 1/O | 1/O |
| L24 | I/O | I/O | 1/0 |
| L25 | I/O | I/O | I/O |
| L26 | NC | I/O | I/O |
| M1 | GL | GL | GL |
| M2 | GL | GL | GL |
| M3 | I/O | I/O | I/O |
| M4 | I/O | I/O | I/O |
| M5 | I/O | I/O | 1/O |
| M11 | GND | GND | GND |
| M12 | GND | GND | GND |
| M13 | GND | GND | GND |
| M14 | GND | GND | GND |
| M15 | GND | GND | GND |
| M16 | GND | GND | GND |
| M22 | GL | GL | GL |
| M23 | I/O | I/O | I/O |
| M24 | 1/0 | 1/O | 1/O |
| M25 | 1/O | 1/O | 1/O |
| M26 | NC | I/O | 1/0 |
| N1 | NC | I/O | 1/O |
| N2 | I/O | I/O | 1/0 |
| N3 | I/O | I/O | I/O |
| N4 | 1/O | I/O | 1/O |
| N5 | I/O | I/O | 1/O |
| N11 | GND | GND | GND |
| N12 | GND | GND | GND |
| N13 | GND | GND | GND |
| N14 | GND | GND | GND |
| N15 | GND | GND | GND |
| N16 | GND | GND | GND |
| N22 | I/O | I/O | I/O |
| N23 | GL | GL | GL |
| N24 | I/O | I/O | I/O |
| N25 | I/O | I/O | 1/O |
| N26 | I/O | I/O | I/O |

456-Pin PBGA (Continued)

| Pin Number | $\begin{gathered} \text { A500K130 } \\ \text { Function } \end{gathered}$ | $\begin{aligned} & \hline \text { A500K180 } \\ & \text { Function } \end{aligned}$ | $\begin{gathered} \hline \text { A500K270 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: | :---: | :---: |
| P1 | NC | I/O | I/O |
| P2 | I/O | I/O | 1/0 |
| P3 | I/O | I/O | 1/O |
| P4 | I/O | 1/O | 1/O |
| P5 | I/O | I/O | 1/O |
| P11 | GND | GND | GND |
| P12 | GND | GND | GND |
| P13 | GND | GND | GND |
| P14 | GND | GND | GND |
| P15 | GND | GND | GND |
| P16 | GND | GND | GND |
| P22 | I/O | I/O | I/O |
| P23 | I/O | I/O | 1/O |
| P24 | I/O | I/O | I/O |
| P25 | I/O | I/O | I/O |
| P26 | NC | I/O | I/O |
| R1 | I/O | I/O | I/O |
| R2 | I/O | I/O | I/O |
| R3 | I/O | 1/O | I/O |
| R4 | I/O | I/O | I/O |
| R5 | I/O | I/O | I/O |
| R11 | GND | GND | GND |
| R12 | GND | GND | GND |
| R13 | GND | GND | GND |
| R14 | GND | GND | GND |
| R15 | GND | GND | GND |
| R16 | GND | GND | GND |
| R22 | I/O | I/O | I/O |
| R23 | I/O | I/O | I/O |
| R24 | I/O | 1/O | I/O |
| R25 | I/O | I/O | I/O |
| R26 | NC | 1/0 | 1/O |
| T1 | NC | I/O | I/O |
| T2 | I/O | I/O | 1/O |
| T3 | I/O | I/O | I/O |
| T4 | I/O | I/O | I/O |
| T5 | I/O | I/O | I/O |
| T11 | GND | GND | GND |
| T12 | GND | GND | GND |
| T13 | GND | GND | GND |
| T14 | GND | GND | GND |
| T15 | GND | GND | GND |
| T16 | GND | GND | GND |
| T22 | I/O | I/O | I/O |


| Pin Number | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| T23 | I/O | I/O | I/O |
| T24 | 1/O | I/O | 1/O |
| T25 | I/O | I/O | 1/O |
| T26 | I/O | I/O | I/O |
| U1 | NC | I/O | I/O |
| U2 | I/O | I/O | I/O |
| U3 | I/O | I/O | I/O |
| U4 | I/O | I/O | 1/0 |
| U5 | I/O | I/O | I/O |
| U22 | 1/O | I/O | I/O |
| U23 | I/O | I/O | I/O |
| U24 | I/O | I/O | I/O |
| U25 | I/O | I/O | 1/O |
| U26 | NC | I/O | I/O |
| V1 | I/O | I/O | I/O |
| V2 | I/O | I/O | I/O |
| V3 | I/O | I/O | 1/O |
| V4 | I/O | I/O | I/O |
| V5 | I/O | I/O | I/O |
| V22 | I/O | I/O | I/O |
| V23 | I/O | I/O | I/O |
| V24 | I/O | I/O | I/O |
| V25 | I/O | I/O | I/O |
| V26 | NC | I/O | I/O |
| W1 | NC | I/O | I/O |
| W2 | I/O | I/O | I/O |
| W3 | I/O | 1/0 | I/O |
| W4 | I/O | I/O | I/O |
| W5 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| W22 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| W23 | I/O | I/O | I/O |
| W24 | I/O | I/O | I/O |
| W25 | I/O | I/O | I/O |
| W26 | I/O | I/O | I/O |
| Y1 | NC | I/O | I/O |
| Y2 | I/O | I/O | I/O |
| Y3 | I/O | I/O | I/O |
| Y4 | I/O | I/O | I/O |
| Y5 | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| Y22 | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| Y23 | I/O | I/O | I/O |
| Y24 | I/O | I/O | I/O |
| Y25 | I/O | I/O | I/O |
| Y26 | NC | I/O | 1/O |

## Package Assignments (Continued)

## 144-FBGA (Bottom View)

|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
| :---: | :---: |
| B | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |
|  | $\bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc \bigcirc$ |

144-pin FBGA

| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K050 Function | A500K130 Function | $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K050 Functio | A500K130 Function | $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K050 Function | A500K130 Function |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A1 | 1/0 | 1/0 | D1 | 1/0 | 1/0 | G1 | 1/0 | 1/O |
| A2 | I/O | 1/0 | D2 | 1/0 | 1/0 | G2 | GND | GND |
| A3 | I/O | I/O | D3 | 1/0 | 1/0 | G3 | I/O | I/O |
| A4 | I/O | 1/0 | D4 | 1/0 | 1/0 | G4 | I/O | I/O |
| A5 | I/O | I/O | D5 | 1/0 | 1/0 | G5 | GND | GND |
| A6 | GND | GND | D6 | I/O | 1/0 | G6 | GND | GND |
| A7 | I/O | I/O | D7 | 1/0 | 1/0 | G7 | GND | GND |
| A8 | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | D8 | 1/0 | 1/0 | G8 | I/O | I/O |
| A9 | I/O | I/O | D9 | 1/0 | 1/0 | G9 | 1/0 | 1/0 |
| A10 | I/O | 1/0 | D10 | I/O | 1/0 | G10 | 1/0 | I/O |
| A11 | I/O | 1/0 | D11 | 1/0 | 1/0 | G11 | 1/0 | I/O |
| A12 | I/O | I/O | D12 | I/O | I/O | G12 | I/O | I/O |
| B1 | I/O | I/O | E1 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ | H1 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| B2 | GND | GND | E2 | I/O | 1/0 | H2 | I/O | I/O |
| B3 | I/O | I/O | E3 | I/O | I/O | H3 | 1/0 | 1/0 |
| B4 | 1/0 | 1/0 | E4 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | H4 | 1/0 | I/O |
| B5 | I/O | I/O | E5 | I/O | I/O | H5 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| B6 | I/O | 1/0 | E6 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | H6 | I/O | I/O |
| B7 | I/O | I/O | E7 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | H7 | I/O | I/O |
| B8 | I/O | 1/0 | E8 | I/O | I/O | H8 | 1/0 | 1/0 |
| B9 | I/O | I/O | E9 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | H9 | I/O | I/O |
| B10 | I/O | I/O | E10 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | H10 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| B11 | GND | GND | E11 | I/O | 1/O | H11 | I/O | I/O |
| B12 | I/O | I/O | E12 | I/O | I/O | H12 | $\mathrm{V}_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| C1 | 1/0 | 1/0 | F1 | GL | GL | J1 | I/O | I/O |
| C2 | GL | GL | F2 | I/O | I/O | J2 | I/O | I/O |
| C3 | I/O | I/O | F3 | I/O | I/O | J3 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| C4 | $\mathrm{V}_{\text {DLL }}$ | $\mathrm{V}_{\text {DDL }}$ | F4 | I/O | I/O | J4 | I/O | I/O |
| C5 | I/O | I/O | F5 | GND | GND | J5 | I/O | I/O |
| C6 | I/O | I/O | F6 | GND | GND | J6 | I/O | I/O |
| C7 | I/O | I/O | F7 | GND | GND | J7 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| C8 | 1/0 | 1/0 | F8 | I/O | I/O | J8 | TCK | TCK |
| C9 | 1/0 | 1/0 | F9 | GL | GL | J9 | I/O | I/O |
| C10 | I/O | I/O | F10 | GND | GND | J10 | TDO | TDO |
| C11 | 1/0 | 1/0 | F11 | I/O | I/O | J11 | I/O | I/O |
| C12 | I/O | 1/0 | F12 | GL | GL | J12 | 1/O | I/O |

144-pin FBGA (Continued)

| Pin <br> Number | A500K050 <br> Function | A500K130 <br> Function |
| :---: | :---: | :---: |
| K1 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K2 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K3 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K4 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K5 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K6 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K7 | GND | GND |
| K8 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K9 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K10 | GND | GND |
| K11 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| K12 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |


| Pin <br> Number | A500K050 <br> Function | A500K130 <br> Function |
| :---: | :---: | :---: |
| L1 | GND | GND |
| L2 | I/O | I/O |
| L3 | I/O | I/O |
| L4 | I/O | I/O |
| L5 | V DDP $^{\text {L6 }}$ | VDDP |
| L6 | I/O | I/O |
| L7 | I/O | I/O |
| L8 | I/O | I/O |
| L9 | TMS | TMS |
| L10 | RCK | RCK |
| L11 | I/O | I/O |
| L12 | TRST | TRST |


| Pin <br> Number | A500K050 <br> Function | A500K130 <br> Function |
| :---: | :---: | :---: |
| M1 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M2 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M3 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M 4 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M5 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M6 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M7 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M8 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| M9 | TDI | TDI |
| M10 | $\mathrm{V}_{\mathrm{DDP}}$ | $\mathrm{V}_{\mathrm{DDP}}$ |
| M11 | $\mathrm{V}_{\mathrm{PP}}$ | $\mathrm{V}_{\mathrm{PP}}$ |
| M12 | $\mathrm{V}_{\mathrm{PN}}$ | $\mathrm{V}_{\mathrm{PN}}$ |

## Package Assignments (Continued)

## 256-FBGA (Bottom View)



256-pin FBGA

| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| A1 | GND | GND | GND |
| A2 | I/O | I/O | I/O |
| A3 | I/O | 1/0 | I/O |
| A4 | I/O | I/O | I/O |
| A5 | I/O | I/O | I/O |
| A6 | I/O | 1/0 | I/O |
| A7 | I/O | I/O | I/O |
| A8 | I/O | I/O | I/O |
| A9 | 1/0 | I/O | I/O |
| A10 | I/O | I/O | I/O |
| A11 | 1/0 | 1/0 | I/O |
| A12 | 1/0 | I/O | I/O |
| A13 | I/O | I/O | I/O |
| A14 | I/O | 1/0 | 1/0 |
| A15 | I/O | I/O | I/O |
| A16 | GND | GND | GND |
| B1 | I/O | I/O | I/O |
| B2 | 1/0 | I/O | 1/0 |
| B3 | 1/0 | 1/0 | 1/0 |
| B4 | I/O | I/O | I/O |
| B5 | 1/0 | 1/0 | I/O |
| B6 | 1/0 | I/O | I/O |
| B7 | 1/0 | 1/0 | 1/0 |
| B8 | 1/0 | 1/0 | I/O |
| B9 | 1/0 | I/O | I/O |
| B10 | 1/0 | I/O | 1/0 |
| B11 | I/O | I/O | I/O |
| B12 | 1/0 | I/O | I/O |
| B13 | 1/0 | I/O | I/O |
| B14 | 1/0 | 1/0 | I/O |
| B15 | 1/0 | 1/0 | I/O |
| B16 | 1/0 | I/O | I/O |
| C1 | 1/0 | 1/0 | I/O |
| C2 | I/O | 1/0 | I/O |
| C3 | 1/0 | I/O | I/O |
| C4 | 1/0 | 1/0 | I/O |
| C5 | 1/0 | 1/0 | I/O |
| C6 | 1/0 | I/O | I/O |
| C7 | 1/0 | I/O | 1/O |


| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| C8 | 1/0 | 1/0 | 1/0 |
| C9 | 1/0 | 1/0 | I/O |
| C10 | 1/0 | 1/0 | 1/0 |
| C11 | 1/0 | 1/0 | I/O |
| C12 | 1/0 | 1/0 | 1/0 |
| C13 | 1/0 | 1/0 | I/O |
| C14 | I/O | I/O | 1/0 |
| C15 | 1/0 | 1/0 | 1/0 |
| C16 | I/O | I/O | I/O |
| D1 | 1/0 | I/O | 1/0 |
| D2 | 1/0 | 1/0 | 1/0 |
| D3 | 1/0 | 1/0 | I/O |
| D4 | 1/0 | 1/0 | 1/0 |
| D5 | 1/0 | I/O | 1/0 |
| D6 | 1/0 | I/O | 1/0 |
| D7 | I/O | 1/0 | 1/0 |
| D8 | 1/0 | I/O | 1/0 |
| D9 | 1/0 | 1/0 | I/O |
| D10 | 1/0 | 1/0 | I/O |
| D11 | 1/0 | 1/0 | 1/0 |
| D12 | 1/0 | 1/0 | I/O |
| D13 | 1/0 | I/O | I/O |
| D14 | I/O | I/O | I/O |
| D15 | 1/0 | I/O | I/O |
| D16 | 1/0 | I/O | 1/0 |
| E1 | I/O | I/O | I/O |
| E2 | 1/0 | 1/0 | I/O |
| E3 | I/O | 1/0 | I/O |
| E4 | I/O | 1/0 | 1/0 |
| E5 | I/O | I/O | I/O |
| E6 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| E7 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| E8 | I/O | I/O | I/O |
| E9 | I/O | I/O | I/O |
| E10 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| E11 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| E12 | I/O | I/O | I/O |
| E13 | 1/0 | 1/0 | 1/0 |
| E14 | 1/0 | 1/0 | I/O |

## 256-pin FBGA (Continued)

| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| E15 | I/O | I/O | I/O |
| E16 | I/O | I/O | I/O |
| F1 | I/O | I/O | I/O |
| F2 | I/O | I/O | I/O |
| F3 | I/O | I/O | I/O |
| F4 | I/O | I/O | I/O |
| F5 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| F6 | GND | GND | GND |
| F7 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| F8 | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $\mathrm{V}_{\text {DDL }}$ |
| F9 | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| F10 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| F11 | GND | GND | GND |
| F12 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| F13 | I/O | I/O | I/O |
| F14 | I/O | I/O | I/O |
| F15 | I/O | I/O | I/O |
| F16 | I/O | I/O | I/O |
| G1 | I/O | I/O | I/O |
| G2 | I/O | I/O | I/O |
| G3 | I/O | I/O | I/O |
| G4 | I/O | I/O | I/O |
| G5 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| G6 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| G7 | GND | GND | GND |
| G8 | GND | GND | GND |
| G9 | GND | GND | GND |
| G10 | GND | GND | GND |
| G11 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| G12 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| G13 | I/O | I/O | I/O |
| G14 | I/O | I/O | I/O |
| G15 | I/O | I/O | I/O |
| G16 | I/O | I/O | I/O |
| H1 | GL | GL | GL |
| H2 | I/O | I/O | I/O |
| H3 | I/O | I/O | I/O |
| H4 | I/O | I/O | I/O |
| H5 | I/O | I/O | I/O |


| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| H6 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| H7 | GND | GND | GND |
| H8 | GND | GND | GND |
| H9 | GND | GND | GND |
| H10 | GND | GND | GND |
| H11 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| H12 | I/O | I/O | I/O |
| H13 | 1/0 | I/O | 1/0 |
| H14 | I/O | I/O | 1/0 |
| H15 | I/O | I/O | I/O |
| H16 | GL | GL | GL |
| J1 | GL | GL | GL |
| J2 | I/O | I/O | I/O |
| J3 | 1/0 | I/O | I/O |
| J4 | 1/0 | I/O | 1/0 |
| J5 | I/O | I/O | I/O |
| J6 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| J7 | GND | GND | GND |
| J8 | GND | GND | GND |
| J9 | GND | GND | GND |
| J10 | GND | GND | GND |
| J11 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| J12 | I/O | I/O | I/O |
| J13 | 1/0 | I/O | I/O |
| J14 | I/O | I/O | I/O |
| J15 | I/O | I/O | 1/0 |
| J16 | GL | GL | GL |
| K1 | I/O | I/O | I/O |
| K2 | 1/0 | I/O | 1/0 |
| K3 | 1/0 | I/O | I/O |
| K4 | 1/0 | I/O | I/O |
| K5 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| K6 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| K7 | GND | GND | GND |
| K8 | GND | GND | GND |
| K9 | GND | GND | GND |
| K10 | GND | GND | GND |
| K11 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| K12 | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |

256-pin FBGA (Continued)

| Pin Number | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| K13 | I/O | I/O | I/O |
| K14 | I/O | I/O | I/O |
| K15 | I/O | I/O | I/O |
| K16 | I/O | I/O | I/O |
| L1 | I/O | I/O | I/O |
| L2 | I/O | I/O | I/O |
| L3 | I/O | I/O | I/O |
| L4 | I/O | I/O | I/O |
| L5 | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| L6 | GND | GND | GND |
| L7 | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| L8 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| L9 | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| L10 | $\mathrm{V}_{\text {DDL }}$ | $V_{\text {DDL }}$ | $V_{\text {DDL }}$ |
| L11 | GND | GND | GND |
| L12 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| L13 | I/O | I/O | I/O |
| L14 | I/O | I/O | I/O |
| L15 | I/O | I/O | I/O |
| L16 | I/O | I/O | I/O |
| M1 | I/O | I/O | I/O |
| M2 | I/O | I/O | I/O |
| M3 | I/O | I/O | I/O |
| M4 | I/O | I/O | I/O |
| M5 | I/O | I/O | I/O |
| M6 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ |
| M7 | $V_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| M8 | I/O | I/O | I/O |
| M9 | I/O | I/O | I/O |
| M10 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| M11 | $\mathrm{V}_{\text {DDP }}$ | $\mathrm{V}_{\text {DDP }}$ | $V_{\text {DDP }}$ |
| M12 | I/O | I/O | I/O |
| M13 | I/O | I/O | I/O |
| M14 | I/O | I/O | I/O |
| M15 | I/O | I/O | I/O |
| M16 | I/O | I/O | I/O |
| N1 | I/O | I/O | I/O |
| N2 | I/O | I/O | I/O |
| N3 | I/O | I/O | I/O |


| Pin Number | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| N4 | I/O | I/O | I/O |
| N5 | I/O | I/O | I/O |
| N6 | I/O | I/O | I/O |
| N7 | I/O | I/O | I/O |
| N8 | I/O | I/O | I/O |
| N9 | I/O | I/O | I/O |
| N10 | I/O | I/O | I/O |
| N11 | I/O | I/O | I/O |
| N12 | I/O | I/O | I/O |
| N13 | I/O | I/O | I/O |
| N14 | RCK | RCK | RCK |
| N15 | I/O | I/O | I/O |
| N16 | I/O | I/O | I/O |
| P1 | I/O | I/O | I/O |
| P2 | I/O | I/O | I/O |
| P3 | I/O | I/O | I/O |
| P4 | I/O | I/O | I/O |
| P5 | I/O | I/O | I/O |
| P6 | I/O | I/O | I/O |
| P7 | I/O | I/O | I/O |
| P8 | I/O | I/O | I/O |
| P9 | I/O | I/O | I/O |
| P10 | I/O | I/O | I/O |
| P11 | I/O | I/O | I/O |
| P12 | I/O | I/O | I/O |
| P13 | TCK | TCK | TCK |
| P14 | VPP | VPP | VPP |
| P15 | TRST | TRST | TRST |
| P16 | I/O | I/O | I/O |
| R1 | I/O | I/O | I/O |
| R2 | I/O | I/O | I/O |
| R3 | I/O | I/O | I/O |
| R4 | I/O | I/O | I/O |
| R5 | I/O | I/O | I/O |
| R6 | I/O | I/O | I/O |
| R7 | I/O | I/O | I/O |
| R8 | I/O | I/O | I/O |
| R9 | I/O | I/O | I/O |
| R10 | I/O | I/O | I/O |

## 256-pin FBGA (Continued)

| Pin Number | A500K130 Function | A500K180 Function | A500K270 Function |
| :---: | :---: | :---: | :---: |
| R11 | I/O | I/O | I/O |
| R12 | I/O | I/O | I/O |
| R13 | I/O | I/O | I/O |
| R14 | TDI | TDI | TDI |
| R15 | $V_{P N}$ | $V_{P N}$ | $V_{\text {PN }}$ |
| R16 | TDO | TDO | TDO |
| T1 | GND | GND | GND |
| T2 | I/O | I/O | I/O |
| T3 | I/O | I/O | I/O |
| T4 | I/O | I/O | I/O |
| T5 | I/O | I/O | I/O |


| Pin <br> Number | A500K130 <br> Function | A500K180 <br> Function | A500K270 <br> Function |
| :---: | :---: | :---: | :---: |
| T 6 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 7 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 8 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 9 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 10 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 11 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 12 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 13 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 14 | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ | $\mathrm{I} / \mathrm{O}$ |
| T 15 | TMS | TMS | TMS |
| T 16 | GND | GND | GND |

## Package Assignments (Continued)

## 676-pin FBGA (Bottom View)

$\begin{array}{lllllllllllllllllllllllllll}26 & 25 & 24 & 23 & 22 & 21 & 20 & 19 & 18 & 17 & 16 & 15 & 14 & 13 & 12 & 11 & 10 & 9 & 8 & 7 & 6 & 5 & 4 & 3 & 2 & 1\end{array}$

| ००००००००००००००००००००००००० ○○○○○○○○○○○○○○○○○○○○○○○○○ ००OOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO ००००००OOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO ○○OOOOOOOO OOOO OOOOOOOOOOO ०००००००००० ०० Oी० ००००००००००० OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO OOOOOOOOOOOOOOOOOOOOOOOOO |
| :---: |

## 676-Pin FBGA

| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K270 Function | Pin Number | A500K270 Function |
| :---: | :---: | :---: | :---: |
| A1 | GND | AA13 | I/O |
| A2 | GND | AA14 | I/O |
| A3 | I/O | AA15 | I/O |
| A4 | I/O | AA16 | I/O |
| A5 | I/O | AA17 | I/O |
| A6 | I/O | AA18 | I/O |
| A7 | I/O | AA19 | I/O |
| A8 | I/O | AA20 | I/O |
| A9 | I/O | AA21 | TDO |
| A10 | I/O | AA22 | GND |
| A11 | I/O | AA23 | GND |
| A12 | I/O | AA24 | I/O |
| A13 | I/O | AA25 | I/O |
| A14 | I/O | AA26 | I/O |
| A15 | I/O | AB1 | I/O |
| A16 | I/O | AB2 | I/O |
| A17 | I/O | AB3 | I/O |
| A18 | I/O | AB4 | I/O |
| A19 | I/O | AB5 | I/O |
| A20 | I/O | AB6 | GND |
| A21 | I/O | AB7 | GND |
| A22 | I/O | AB8 | I/O |
| A23 | I/O | AB9 | I/O |
| A24 | I/O | AB10 | I/O |
| A25 | GND | AB11 | I/O |
| A26 | GND | AB12 | I/O |
| AA1 | I/O | AB13 | I/O |
| AA2 | I/O | AB14 | I/O |
| AA3 | I/O | AB15 | I/O |
| AA4 | I/O | AB16 | I/O |
| AA5 | I/O | AB17 | I/O |
| AA6 | GND | AB18 | I/O |
| AA7 | I/O | AB19 | I/O |
| AA8 | I/O | AB20 | I/O |
| AA9 | I/O | AB21 | TCK |
| AA10 | I/O | AB22 | TRST |
| AA11 | I/O | AB23 | I/O |
| AA12 | I/O | AB24 | I/O |


| $\begin{aligned} & \text { Pin } \\ & \text { Number } \end{aligned}$ | $\begin{gathered} \text { A500K270 } \\ \text { Function } \end{gathered}$ |
| :---: | :---: |
| AB25 | I/O |
| AB26 | I/O |
| AC1 | I/O |
| AC2 | I/O |
| AC3 | I/O |
| AC4 | I/O |
| AC5 | GND |
| AC6 | I/O |
| AC7 | I/O |
| AC8 | I/O |
| AC9 | GND |
| AC10 | I/O |
| AC11 | I/O |
| AC12 | I/O |
| AC13 | I/O |
| AC14 | I/O |
| AC15 | I/O |
| AC16 | I/O |
| AC17 | I/O |
| AC18 | I/O |
| AC19 | I/O |
| AC20 | I/O |
| AC21 | I/O |
| AC22 | TMS |
| AC23 | RCK |
| AC24 | I/O |
| AC25 | I/O |
| AC26 | I/O |
| AD1 | I/O |
| AD2 | I/O |
| AD3 | I/O |
| AD4 | I/O |
| AD5 | I/O |
| AD6 | I/O |
| AD7 | I/O |
| AD8 | I/O |
| AD9 | I/O |
| AD10 | I/O |


| Pin Number | A500K270 Function |
| :---: | :---: |
| AD11 | I/O |
| AD12 | I/O |
| AD13 | I/O |
| AD14 | I/O |
| AD15 | I/O |
| AD16 | I/O |
| AD17 | I/O |
| AD18 | I/O |
| AD19 | I/O |
| AD20 | I/O |
| AD21 | I/O |
| AD22 | I/O |
| AD23 | TDI |
| AD24 | $V_{P N}$ |
| AD25 | I/O |
| AD26 | I/O |
| AE1 | GND |
| AE2 | GND |
| AE3 | GND |
| AE4 | I/O |
| AE5 | I/O |
| AE6 | I/O |
| AE7 | I/O |
| AE8 | I/O |
| AE9 | I/O |
| AE10 | I/O |
| AE11 | I/O |
| AE12 | I/O |
| AE13 | I/O |
| AE14 | I/O |
| AE15 | I/O |
| AE16 | I/O |
| AE17 | I/O |
| AE18 | I/O |
| AE19 | I/O |
| AE20 | I/O |
| AE21 | I/O |
| AE22 | I/O |


| Pin Number | A500K270 Function |
| :---: | :---: |
| AE23 | I/O |
| AE24 | I/O |
| AE25 | GND |
| AE26 | GND |
| AF1 | GND |
| AF2 | GND |
| AF3 | GND |
| AF4 | GND |
| AF5 | I/O |
| AF6 | I/O |
| AF7 | I/O |
| AF8 | I/O |
| AF9 | I/O |
| AF10 | I/O |
| AF11 | I/O |
| AF12 | I/O |
| AF13 | I/O |
| AF14 | I/O |
| AF15 | I/O |
| AF16 | I/O |
| AF17 | I/O |
| AF18 | I/O |
| AF19 | I/O |
| AF20 | I/O |
| AF21 | I/O |
| AF22 | I/O |
| AF23 | I/O |
| AF24 | I/O |
| AF25 | GND |
| AF26 | GND |
| B1 | GND |
| B2 | GND |
| B3 | GND |
| B4 | GND |
| B5 | I/O |
| B6 | I/O |
| B7 | I/O |
| B8 | I/O |

676-Pin FBGA (Continued)

| Pin Number | A500K270 Function |
| :---: | :---: |
| B9 | I/O |
| B10 | I/O |
| B11 | I/O |
| B12 | I/O |
| B13 | I/O |
| B14 | I/O |
| B15 | I/O |
| B16 | I/O |
| B17 | I/O |
| B18 | I/O |
| B19 | I/O |
| B20 | I/O |
| B21 | I/O |
| B22 | I/O |
| B23 | I/O |
| B24 | I/O |
| B25 | GND |
| B26 | GND |
| C1 | GND |
| C2 | GND |
| C3 | GND |
| C4 | GND |
| C5 | I/O |
| C6 | I/O |
| C7 | I/O |
| C8 | I/O |
| C9 | I/O |
| C10 | I/O |
| C11 | I/O |
| C12 | I/O |
| C13 | I/O |
| C14 | I/O |
| C15 | I/O |
| C16 | I/O |
| C17 | I/O |
| C18 | I/O |
| C19 | I/O |
| C20 | I/O |


| Pin Number | A500K270 <br> Function |
| :---: | :---: |
| C21 | I/O |
| C22 | I/O |
| C23 | I/O |
| C24 | I/O |
| C25 | I/O |
| C26 | I/O |
| D1 | I/O |
| D2 | I/O |
| D3 | GND |
| D4 | I/O |
| D5 | I/O |
| D6 | I/O |
| D7 | I/O |
| D8 | I/O |
| D9 | I/O |
| D10 | I/O |
| D11 | I/O |
| D12 | I/O |
| D13 | I/O |
| D14 | I/O |
| D15 | I/O |
| D16 | I/O |
| D17 | I/O |
| D18 | I/O |
| D19 | I/O |
| D20 | I/O |
| D21 | I/O |
| D22 | I/O |
| D23 | I/O |
| D24 | I/O |
| D25 | I/O |
| D26 | I/O |
| E1 | I/O |
| E2 | I/O |
| E3 | I/O |
| E4 | I/O |
| E5 | I/O |
| E6 | I/O |


| Pin Number | A500K270 Function | Pin Number | A500K270 Function |
| :---: | :---: | :---: | :---: |
| E7 | I/O | F19 | I/O |
| E8 | I/O | F20 | I/O |
| E9 | I/O | F21 | I/O |
| E10 | I/O | F22 | I/O |
| E11 | I/O | F23 | I/O |
| E12 | I/O | F24 | I/O |
| E13 | I/O | F25 | I/O |
| E14 | I/O | F26 | I/O |
| E15 | I/O | G1 | I/O |
| E16 | I/O | G2 | I/O |
| E17 | I/O | G3 | I/O |
| E18 | I/O | G4 | I/O |
| E19 | I/O | G5 | I/O |
| E20 | I/O | G6 | I/O |
| E21 | I/O | G7 | I/O |
| E22 | I/O | G8 | $V_{\text {DDL }}$ |
| E23 | I/O | G9 | NC |
| E24 | I/O | G10 | NC |
| E25 | I/O | G11 | NC |
| E26 | I/O | G12 | NC |
| F1 | I/O | G13 | NC |
| F2 | I/O | G14 | NC |
| F3 | I/O | G15 | NC |
| F4 | I/O | G16 | NC |
| F5 | GND | G17 | NC |
| F6 | I/O | G18 | NC |
| F7 | NC | G20 | NC |
| F8 | I/O | G19 | $\mathrm{V}_{\text {DDP }}$ |
| F9 | I/O | G21 | I/O |
| F10 | I/O | G22 | I/O |
| F11 | I/O | G23 | I/O |
| F12 | I/O | G24 | I/O |
| F13 | I/O | G25 | I/O |
| F14 | I/O | G26 | I/O |
| F15 | I/O | H1 | I/O |
| F16 | I/O | H2 | I/O |
| F17 | I/O | H3 | I/O |
| F18 | I/O | H4 | I/O |


| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K270 Function |
| :---: | :---: |
| H5 | I/O |
| H6 | I/O |
| H7 | $\mathrm{V}_{\text {DDP }}$ |
| H8 | $V_{\text {DDL }}$ |
| H9 | $V_{\text {DDP }}$ |
| H10 | $V_{\text {DDP }}$ |
| H11 | $V_{\text {DDP }}$ |
| H12 | $V_{\text {DDP }}$ |
| H13 | $V_{\text {DDP }}$ |
| H14 | $V_{\text {DDP }}$ |
| H15 | $V_{\text {DDP }}$ |
| H16 | $V_{\text {DDP }}$ |
| H17 | $V_{\text {DDP }}$ |
| H18 | $V_{\text {DDP }}$ |
| H19 | $V_{\text {DDL }}$ |
| H20 | $V_{\text {DDL }}$ |
| H21 | I/O |
| H22 | I/O |
| H23 | I/O |
| H24 | I/O |
| H25 | I/O |
| H26 | I/O |
| J1 | I/O |
| J2 | I/O |
| J3 | I/O |
| J4 | I/O |
| J5 | I/O |
| J6 | I/O |
| J7 | NC |
| J8 | $V_{\text {DDP }}$ |
| J9 | $V_{\text {DDL }}$ |
| J10 | $V_{\text {DDL }}$ |
| J11 | $V_{\text {DDL }}$ |
| $J 12$ | $V_{\text {DDL }}$ |
| $J 13$ | $V_{\text {DDL }}$ |
| J14 | $V_{\text {DDL }}$ |
| J15 | $V_{\text {DDL }}$ |
| J16 | $V_{\text {DDL }}$ |

676-Pin FBGA (Continued)

| Pin Number | A500K270 Function |
| :---: | :---: |
| J17 | $\mathrm{V}_{\text {DDL }}$ |
| J18 | $V_{\text {DDL }}$ |
| J19 | $V_{\text {DDP }}$ |
| J20 | NC |
| J21 | I/O |
| J22 | I/O |
| J23 | I/O |
| J24 | I/O |
| J25 | I/O |
| J26 | I/O |
| K1 | I/O |
| K2 | I/O |
| K3 | I/O |
| K4 | I/O |
| K5 | I/O |
| K6 | I/O |
| K7 | NC |
| K8 | $V_{\text {DDP }}$ |
| K9 | $V_{\text {DDL }}$ |
| K10 | GND |
| K11 | GND |
| K12 | GND |
| K13 | GND |
| K14 | GND |
| K15 | GND |
| K16 | GND |
| K17 | GND |
| K18 | $V_{\text {DDL }}$ |
| K19 | $\mathrm{V}_{\text {DDP }}$ |
| K20 | NC |
| K21 | I/O |
| K22 | I/O |
| K23 | I/O |
| K24 | I/O |
| K25 | I/O |
| K26 | I/O |
| L1 | I/O |
| L2 | I/O |


| Pin Number | A500K270 Function |
| :---: | :---: |
| L3 | I/O |
| L4 | I/O |
| L5 | I/O |
| L6 | I/O |
| L7 | NC |
| L8 | $V_{\text {DDP }}$ |
| L9 | $V_{\text {DDL }}$ |
| L10 | GND |
| L11 | GND |
| L12 | GND |
| L13 | GND |
| L14 | GND |
| L15 | GND |
| L16 | GND |
| L17 | GND |
| L18 | $V_{\text {DDL }}$ |
| L19 | $V_{\text {DDP }}$ |
| L20 | NC |
| L21 | I/O |
| L22 | I/O |
| L23 | I/O |
| L24 | I/O |
| L25 | I/O |
| L26 | I/O |
| M1 | I/O |
| M2 | I/O |
| M3 | I/O |
| M4 | I/O |
| M5 | I/O |
| M6 | I/O |
| M7 | NC |
| M8 | $V_{\text {DDP }}$ |
| M9 | $V_{\text {DDL }}$ |
| M10 | GND |
| M11 | GND |
| M12 | GND |
| M13 | GND |
| M14 | GND |


| Pin Number | A500K270 Function |
| :---: | :---: |
| M15 | GND |
| M16 | GND |
| M17 | GND |
| M18 | $V_{\text {DDL }}$ |
| M19 | $V_{\text {DDP }}$ |
| M20 | NC |
| M21 | I/O |
| M22 | I/O |
| M23 | I/O |
| M24 | I/O |
| M25 | I/O |
| M26 | I/O |
| N1 | GL |
| N2 | I/O |
| N3 | I/O |
| N4 | I/O |
| N5 | I/O |
| N6 | I/O |
| N7 | NC |
| N8 | $V_{\text {DDP }}$ |
| N9 | $V_{\text {DDL }}$ |
| N10 | GND |
| N11 | GND |
| N12 | GND |
| N13 | GND |
| N14 | GND |
| N15 | GND |
| N16 | GND |
| N17 | GND |
| N18 | $V_{\text {DDL }}$ |
| N19 | $V_{\text {DDP }}$ |
| N20 | NC |
| N21 | I/O |
| N22 | GL |
| N23 | I/O |
| N24 | I/O |
| N25 | GL |
| N26 | I/O |


| $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K270 Function | $\begin{gathered} \text { Pin } \\ \text { Number } \end{gathered}$ | A500K270 Function |
| :---: | :---: | :---: | :---: |
| P1 | GL | R13 | GND |
| P2 | I/O | R14 | GND |
| P3 | I/O | R15 | GND |
| P4 | I/O | R16 | GND |
| P5 | I/O | R17 | GND |
| P6 | I/O | R18 | $V_{\text {DDL }}$ |
| P7 | NC | R19 | $V_{\text {DDP }}$ |
| P8 | $V_{\text {DDP }}$ | R20 | NC |
| P9 | $V_{\text {DDL }}$ | R21 | I/O |
| P10 | GND | R22 | I/O |
| P11 | GND | R23 | I/O |
| P12 | GND | R24 | I/O |
| P13 | GND | R25 | I/O |
| P14 | GND | R26 | I/O |
| P15 | GND | T1 | I/O |
| P16 | GND | T2 | I/O |
| P17 | GND | T3 | I/O |
| P18 | $\mathrm{V}_{\text {DDL }}$ | T4 | I/O |
| P19 | $\mathrm{V}_{\text {DDP }}$ | T5 | I/O |
| P20 | NC | T6 | I/O |
| P21 | I/O | T7 | NC |
| P22 | I/O | T8 | $V_{\text {DDP }}$ |
| P23 | I/O | T9 | $V_{\text {DDL }}$ |
| P24 | I/O | T10 | GND |
| P25 | I/O | T11 | GND |
| P26 | I/O | T12 | GND |
| R1 | I/O | T13 | GND |
| R2 | I/O | T14 | GND |
| R3 | I/O | T15 | GND |
| R4 | I/O | T16 | GND |
| R5 | I/O | T17 | GND |
| R6 | I/O | T18 | $V_{\text {DDL }}$ |
| R7 | NC | T19 | $V_{\text {DDP }}$ |
| R8 | $\mathrm{V}_{\text {DDP }}$ | T20 | NC |
| R9 | $V_{\text {DDL }}$ | T21 | I/O |
| R10 | GND | T22 | I/O |
| R11 | GND | T23 | I/O |
| R12 | GND | T24 | I/O |

676-Pin FBGA (Continued)

| Pin Number | A500K270 Function |
| :---: | :---: |
| T25 | I/O |
| T26 | I/O |
| U1 | I/O |
| U2 | I/O |
| U3 | I/O |
| U4 | I/O |
| U5 | I/O |
| U6 | I/O |
| U7 | NC |
| U8 | $\mathrm{V}_{\text {DDP }}$ |
| U9 | $V_{\text {DDL }}$ |
| U10 | GND |
| U11 | GND |
| U12 | GND |
| U13 | GND |
| U14 | GND |
| U15 | GND |
| U16 | GND |
| U17 | GND |
| U18 | $V_{\text {DDL }}$ |
| U19 | $V_{\text {DDP }}$ |


| Pin <br> Number | A500K270 <br> Function |
| :---: | :---: |
| U 20 | NC |
| U 21 | $\mathrm{I} / \mathrm{O}$ |
| U 22 | $\mathrm{I} / \mathrm{O}$ |
| U 23 | $\mathrm{I} / \mathrm{O}$ |
| U 24 | $\mathrm{I} / \mathrm{O}$ |
| U 25 | $\mathrm{I} / \mathrm{O}$ |
| U 26 | $\mathrm{I} / \mathrm{O}$ |
| V 1 | $\mathrm{I} / \mathrm{O}$ |
| V 2 | $\mathrm{I} / \mathrm{O}$ |
| V 3 | $\mathrm{I} / \mathrm{O}$ |
| V 4 | $\mathrm{I} / \mathrm{O}$ |
| V 5 | $\mathrm{I} / \mathrm{O}$ |
| V 6 | $\mathrm{I} / \mathrm{O}$ |
| V 7 | NC |
| V 8 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| V 9 | $\mathrm{~V}_{\mathrm{DDL}}$ |
| V 10 | $\mathrm{~V}_{\mathrm{DDL}}$ |
| V 11 | $\mathrm{~V}_{\mathrm{DDL}}$ |
| V 12 | $\mathrm{~V}_{\mathrm{DDL}}$ |
| V 13 | $\mathrm{~V}_{\mathrm{DDL}}$ |
| V 14 | $\mathrm{~V}_{\mathrm{DDL}}$ |


| Pin Number | A500K270 Function |
| :---: | :---: |
| V15 | $\mathrm{V}_{\text {DDL }}$ |
| V16 | $V_{\text {DDL }}$ |
| V17 | $V_{\text {DDL }}$ |
| V18 | $V_{\text {DDL }}$ |
| V19 | $V_{\text {DDP }}$ |
| V20 | NC |
| V21 | I/O |
| V22 | I/O |
| V23 | I/O |
| V24 | I/O |
| V25 | I/O |
| V26 | I/O |
| W1 | I/O |
| W2 | I/O |
| W3 | I/O |
| W4 | I/O |
| W5 | I/O |
| W6 | I/O |
| W7 | $\mathrm{V}_{\text {DDL }}$ |
| W8 | $V_{\text {DDL }}$ |
| W9 | $V_{\text {DDP }}$ |


| Pin <br> Number | A500K270 <br> Function |
| :---: | :---: |
| W 10 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 11 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 12 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 13 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 14 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 15 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 16 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 17 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 18 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 19 | $\mathrm{~V}_{\mathrm{DDL}}$ |
| W 20 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| W 21 | $\mathrm{I} / \mathrm{O}$ |
| W 22 | $\mathrm{I} / \mathrm{O}$ |
| W 23 | $\mathrm{I} / \mathrm{O}$ |
| W 24 | $\mathrm{I} / \mathrm{O}$ |
| W 25 | $\mathrm{I} / \mathrm{O}$ |
| W 26 | $\mathrm{I} / \mathrm{O}$ |
| Y 1 | $\mathrm{I} / \mathrm{O}$ |
| Y 2 | $\mathrm{I} / \mathrm{O}$ |
| Y 3 | $\mathrm{I} / \mathrm{O}$ |
| Y 4 | $\mathrm{I} / \mathrm{O}$ |


| Pin <br> Number | A500K270 <br> Function |
| :---: | :---: |
| Y 5 | $\mathrm{I} / \mathrm{O}$ |
| Y 6 | $\mathrm{I} / \mathrm{O}$ |
| Y 7 | $\mathrm{I} / \mathrm{O}$ |
| Y 8 | $\mathrm{~V}_{\mathrm{DDP}}$ |
| Y 9 | NC |
| Y 10 | NC |
| Y 11 | NC |
| Y 12 | NC |
| Y 13 | NC |
| Y 14 | NC |
| Y 15 | NC |
| Y 16 | NC |
| Y 17 | NC |
| Y 18 | NC |
| Y 19 | $\mathrm{~V}_{\mathrm{DDL}}$ |
| Y 20 | V PP |
| Y 21 | $\mathrm{I} / \mathrm{O}$ |
| Y 22 | $\mathrm{I} / \mathrm{O}$ |
| Y 23 | $\mathrm{I} / \mathrm{O}$ |
| Y 24 | $\mathrm{I} / \mathrm{O}$ |
| Y 25 | $\mathrm{I} / \mathrm{O}$ |
| Y 26 | $\mathrm{I} / \mathrm{O}$ |

## List of Changes

The following table lists critical changes that were made in the current version of the document.

| Previous version | Changes in current version (v3.0) | Page |
| :---: | :---: | :---: |
| v2.0 | WDATA has been changed to DI, and RDATA has been changed to DO to make them consistent with the signal names found in the Macro Library Guide. |  |
| Preliminary v1.1 | The "Product Plan" on page 3 has been updated to include the 256-FBGA package. | page 3 |
|  | The "Plastic Device Resources" on page 3 has been updated to include the 256-FBGA package. | page 3 |
|  | Figure 12 and Figure 13 on page 13 have been updated. | page 13 |
|  | The "Design Environment" on page 15 and Figure 17 on page 15 have been updated. | page 15 |
|  | Package Thermal Characteristics table on page 16 has been updated to include the 256-FBGA package. | page 16 |
|  | The "Calculating Power Dissipation" on page 17 has been changed. | page 17 |
|  | The "Programming and Storage Temperature LImits" on page 18 is new. | page 18 |
|  | The "DC Electrical Specifications ( $\mathrm{V}_{\mathrm{DDP}}=2.5 \mathrm{~V}$ )" on page 19 has been updated. | page 19 |
|  | The "DC Electrical Specifications ( $\mathrm{V}_{\mathrm{DDP}}=3.3 \mathrm{~V}$ )" on page 20 has been updated. | page 20 |
|  | The Table 4 on page 28 has been updated. | page 28 |
|  | The Table 5 on page 34 has been updated. | page 34 |
|  | The "256-FBGA (Bottom View)" on page 58 is new. | page 58 |
| Preliminary v1.0 | In the "676-pin FBGA (Bottom View)" on page 63, the functions for pins N1, N22, N25, and P1 have changed from I/O to GL | page 59 |
| Advanced v. 4 | The section, "Clock Trees" on page 8 is new. | page 8 |
|  | The table, "DC Electrical Specifications ( $\mathrm{V}_{\mathrm{DDP}}=3.3 \mathrm{~V}$ )" on page 20 is new. | page 18 |
|  | The table, "AC Specifications (3.3V PCI Operation)" on page 22 is new. | page 20 |
|  | The table, the "Slew Rates Measured at Cout = 10pF (Total Output Load), Nominal Power Supplies and $25^{\circ} \mathrm{C}$ " on page 24 is new. | page 22 |
|  | The numbers found in the "Tristate Buffer Delays (Worst-Case Commercial Conditions, $\mathrm{V}_{\mathrm{DDP}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDL}}=2.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=70^{\circ} \mathrm{C}, f C L O C K=250 \mathrm{MHz}$ )" on page 25 have changed. | page 23 |
|  | The numbers found in the "Output Buffer Delays (Worst-Case Commercial Conditions, $\mathrm{V}_{\mathrm{DDP}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDL}}=2.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=70^{\circ} \mathrm{C}, \mathrm{fCLOCK}=250 \mathrm{MHz}$ )" on page 26 have changed. | page 24 |
|  | The numbers found in the "Input Buffer Delays (Worst-Case Commercial Conditions, $\mathrm{V}_{\mathrm{DDP}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDL}}=2.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=70^{\circ} \mathrm{C}, \mathrm{fCLOCK}=250 \mathrm{MHz}$ )" on page 26 have changed. | page 24 |
|  | The numbers found in the "Global Input Buffer Delays (Worst-Case Commercial Conditions, $\mathrm{V}_{\mathrm{DDP}}=3.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DDL}}=2.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=70^{\circ} \mathrm{C}, \mathrm{fCLOCK}=250 \mathrm{MHz}$ )" on page 27 have changed. | page 25 |
|  | The "144-FBGA (Bottom View)" on page 55 for A500K050 is new. | pages 53-55 |
|  | The "676-pin FBGA (Bottom View)" on page 63 for A500K130 and A500K270 are new. | pages 56-60 |

## Data Sheet Categories

In order to provide the latest information to designers, some data sheets are published before data has been fully characterized. These data sheets are marked as "Advanced" or Preliminary" data sheets. The definition of these categories are as follows:

## Advanced

The data sheet contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production.

## Preliminary

The data sheet contains information based on simulation and/or initial characterization. The information is believed to be correct, but changes are possible.

## Unmarked (production)

The data sheet contains information that is considered to be final.

## Web-only Versions

Web-only versions have three numbers in the version number (example: v2.0.1). A web-only version means Actel is posting the data sheet so customers have the latest information, but we are not printing the version because some information is going to change shortly after posting.

Actel and the Actel logo are registered trademarks of Actel Corporation.
All other trademarks are the property of their owners.

http://www.actel.com

## Actel Europe Ltd.

Maxfli Court, Riverside Way
Camberley, Surrey GU15 3YL United Kingdom
Tel: +44 (0)1276 401450
Fax: +44 (0)1276 401490

## Actel Corporation

955 East Arques Avenue
Sunnyvale, California 94086 USA
Tel: (408) 739-1010
Fax: (408) 739-1540

Actel Asia-Pacific
EXOS Ebisu Bldg. 4F
1-24-14 Ebisu Shibuya-ku
Tokyo 150 Japan
Tel: +81 03-3445-7671
Fax: +81 03-3445-7668


[^0]:    1. If pads are configured for 2.5V operation, they are compliant with 2.5V level signals as defined by JEDEC JESD 8-5. If pads are configured for 3.3V operation, they are compliant to the standard as defined by JEDEC JESD 8-A (LVTTL and LVCMOS).
